



External Communications

Summary Initiatives

JUNE 2026

S.NO	Date	Publication	Headline	Page No	Link	AVE	Quote By
MAGAZINE PRINT							
EXCLUSIVE INTERVIEW							
1	25th June,2026	ET Edge Insights	India's semiconductor future will be built on trust , not just chips	52 -53	N/A	450000	Mr Ashok Chandak President IESA and SEMI India
STANDALONE INDUSTRY STORY							
ONLINE							
1	30th June,2026	First Post	AI is rewriting the memory chip industry. Can India build its own ecosystem?	N/A	Link	42000	Mr Ashok Chandak President IESA and SEMI India
EXCLUSIVE INTERVIEW							
ONLINE							
1	29th June,2026	ET Electronics World	ISM 2.0 needs to boost full ecosystem creation: Navin Bishnoi	N/A	Link	87000	Mr Naveen Bishnoi, Chairperson of IESA
INDUSTRY STORY							
PRINT							
1	26th June,2026	The Hindu Business Line	Building skills & innovation key to electronics industry's \$500 billion target: Experts`	02	N/A	1120415	Mr Ashok Chandak President IESA and SEMI
2	26th June,2026	The Hindu Business Line	India's developed nation ambition rests on MSMEs	01	N/A	903977	Mr Ashok Chandak President IESA and SEMI
Delhi							

3	26th June,2026	The Hindu	'MSMEs must lead India's innovation push to achieve Viksit Bharat goal	17	N/A	110000	Mr Ashok Chandak President IESA and SEMI
Bangalore							
4	26th June,2026	The Hindu	'MSMEs must lead India's innovation push to achieve Viksit Bharat goal	17	N/A	146000	Mr Ashok Chandak President IESA and SEMI
Hyderabad							
5	26th June,2026	The Hindu	'MSMEs must lead India's innovation push to achieve Viksit Bharat goal	17	N/A	135000	Mr Ashok Chandak President IESA and SEMI
Mumbai							
6	26th June,2026	The Hindu	'MSMEs must lead India's innovation push to achieve Viksit Bharat goal	17	N/A	96000	Mr Ashok Chandak President IESA and SEMI
Chennai							
7	26th June,2026	The Hindu	'MSMEs must lead India's innovation push to achieve Viksit Bharat goal	17	N/A	115000	Mr Ashok Chandak President IESA and SEMI
INDUSTRY STORY							
PRINT BENGALORE							
1	25th June,2026	The Hindu	Businessline's MSME meet starts today	17	N/A	243227	Mr Ashok Chandak President IESA
INDUSTRY STORY							
PRINT DELHI							
1	25th June,2026	The Hindu	Businessline's MSME meet starts today	15	N/A	578421	Mr Ashok Chandak

							President IESA
INDUSTRY STORY							
PRINT MUMBAI							
1	25th June,2026	The Hindu	Businessline's MSME meet starts today	13	N/A	72545	Mr Ashok Chandak President IESA
INDUSTRY STORY							
PRINT HYDERABAD							
1	25th June,2026	The Hindu	Businessline's MSME meet starts today	13	N/A	200686	Mr Ashok Chandak President IESA
INDUSTRY STORY							
PRINT CHENNAI							
1	25th June,2026	The Hindu	Businessline's MSME meet starts today	13		1022130	Mr Ashok Chandak President IESA
MAGAZINE PRINT - PANEL DISCUSSION							
INDUSTRY STORY							
1	3rd June2026	Forbes	Reimagining India's Workforce and Workspaces	74 -75	N/A	165000	Mr Ashok Chandak President IESA and SEMI
PRINT							
INDUSTRY STORY - NVIDIA's AI PC push may open opportunities for India's semicon ecosystem							
1	4th June,2026	The Hindu Business Line	NVIDIA's AI PC push may open opportunities for India's semicon ecosystem	12	N/A	87410	Mr Ashok Chandak President IESA and SEMI India

PRINT**INDUSTRY STORY - Focus on design, packaging over wafer race**

1	1st June,2026	The Times of India	Focus on design, packaging over wafer race	11	N/A	336808	Mr Ashok Chandak President IESA and SEMI Raja Manickam, Founder iVP Semi
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INDUSTRY STORY**PRINT**

1	13th June,2026	Deccan Chronicle	Rising memory, PCBs costs may hurt electronic devices	07	N/A	78000	Mr Ashok Chandak President IESA and SEMI
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INDUSTRY STORY**ONLINE - HBL Event**

1	26th June,2026	The Hindu Business Line	businessline MSME Conclave. Building skills, innovation hold the key to India's \$500 billion electronic industry target by 2030	N/A	Link	95000	Mr Ashok Chandak President IESA and SEMI
2	26th June,2026	Silicon India	MSMEs must lead Innovation Push for Viksit Bharat goal says Dr Sharan Prakash Patil	N/A	Link	89000	Mr Ashok Chandak President IESA and SEMI

INDUSTRY STORY**ONLINE**

1	12th June,2026	Deccan Chronicle	Prices of Electronic Devices, Appliances To Go Up 10-25 PC on Supply Worries	N/A	Link	85000	Mr Ashok Chandak President IESA and SEMI
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INDUSTRY STORY**Quote - Record Global Semiconductor Equipment****PRINT BHUBANESWAR**

1	12th June,2026	Samaya	Record Global Semiconductor Equipment	4	N/A	36500	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
2	12th June,2026	Amruta Dunia	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	12	N/A	30000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
3	12th June,2026	Biswabani	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	4	N/A	45000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
4	12th June,2026	Desbarta	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	6	N/A	35000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI

5	12th June,2026	Dharitri	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	17	N/A	30800	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
6	12th June,2026	Kalinga Mail	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	10	N/A	31000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
7	12th June,2026	Mallahar	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	7	N/A	44000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
8	12th June,2026	Manthan	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	9	N/A	29700	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
9	12th June,2026	Orissa Times	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	6	N/A	47000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI

10	12th June,2026	Pratigyan	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	8	N/A	42000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
11	12th June,2026	Sakala	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	15	N/A	32000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
12	12th June,2026	Azad Sipahi	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	12	N/A	40000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
13	12th June,2026	Utkal Samaja	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	8	N/A	27600	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
14	12th June,2026	Swatantra Barta	Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit	5	N/A	36000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI

Quote - Record Global Semiconductor Equipment

PRINT GUJARAT

1	11th June,2026	Divya Gujarat	Global semiconductor equipment spending hits record, strong sign of AI-driven growth; India likely to benefit greatly	2	N/A	19700	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI
2	11th June,2026	Gujarat Pranam	Global semiconductor equipment spending hits record, strong sign of AI-driven growth; India likely to benefit greatly	3	N/A	21300	Mr Ashok Chandak President IESA and SEMI / Mr Ajit Manocha President and CEO of SEMI

EXCLUSIVE INTERVIEW

ONLINE

1	11th June,2026	ANI	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	85000	Mr Naveen Bishnoi, chairperson of IESA
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ANI PICKUPS - INDUSTRY STROY

ONLINE

1	11th June,2026	Telangana Journal	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	28000	Mr Naveen Bishnoi, chairperson of IESA
2	11th June,2026	Karnataka Live	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27975	Mr Naveen Bishnoi, chairperson of IESA

3	11th June,2026	Kashmir Newsline	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27950	Mr Naveen Bishnoi, chairperson of IESA
4	11th June,2026	Rajasthan Ki khabar	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27925	Mr Naveen Bishnoi, chairperson of IESA
5	11th June,2026	Kashmir Breakinhg News	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27900	Mr Naveen Bishnoi, chairperson of IESA
6	11th June,2026	Gujarat Varta	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27875	Mr Naveen Bishnoi, chairperson of IESA
7	11th June,2026	Andhra Pradesh Mirror	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27850	Mr Naveen Bishnoi, chairperson of IESA
8	11th June,2026	Delhi Live News	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27825	Mr Naveen Bishnoi, chairperson of IESA
9	11th June,2026	Indian News Network	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27800	Mr Naveen Bishnoi, chairperson of IESA
10	11th June,2026	Maharashtra Samachar	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27775	Mr Naveen Bishnoi, chairperson of IESA
11	11th June,2026	Bihar 24x7	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain,	N/A	Link	27750	Mr Naveen Bishnoi, chairperson of IESA

			talent. IP: IESA				
12	11th June,2026	South India News	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27725	Mr Naveen Bishnoi,chairperson of IESA
13	11th June,2026	North East Times	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27700	Mr Naveen Bishnoi,chairperson of IESA
14	11th June,2026	Chhattisgarh Today	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27675	Mr Naveen Bishnoi,chairperson of IESA
15	11th June,2026	Haryana Today	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27650	Mr Naveen Bishnoi,chairperson of IESA
16	11th June,2026	Vanakkam Tamil Nadu	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent. IP: IESA	N/A	Link	27625	Mr Naveen Bishnoi,chairperson of IESA
17	11th June,2026	Kolkata Sun	Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent, IP: IESA	N/A	Link	27600	Mr Naveen Bishnoi,chairperson of IESA

QUOTE - REPORT

ONLINE

1	11th June,2026	AEI Dempa	India Targets to Grow from Chip Equipment Boom	N/A	Link	135000	Mr Ashok Chandak President IESA and SEMI / Mr Ajit
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							Manocha President and CEO of SEMI
ONLINE							
INDUSTRY STORY							
1	10th June,2026	DQ India	Karnataka Government provides details of ESDM policies	N/A	Link	86000	IESA has been mentioned
ONLINE							
Quote -Report Worldwide Semiconductor Equipment Market Statistics							
1	10th June,2026	ET Manufacturing	India poised to gain from semiconductor boom as global billings hit record \$36.6 billion in Q1 : Report	N/A	Link	85000	Mr Ajit Manocha President and CEO of SEMI/ Mr Ashok Chandak President IESA and SEMI
2	10th June,2026	Forbes India	Global semiconductor equipment spending hits record \$36.55 billion in Q1 2026; India eyes larger role in supply chain	N/A	Link	89000	Mr Ajit Manocha President and CEO of SEMI/ Mr Ashok Chandak President IESA and SEMI
ONLINE							
QUOTE - INDUSTRY STORY							
1	10th June,2026	Economic Times	SEZ import relief to fast track chip projects	N/A	Link	95000	Mr Ashok Chandak President IESA and SEMI

2	10th June,2026	MSN	SEZ import relief to fast track chip projects	N/A	Link	20000	Mr Ashok Chandak President IESA and SEMI
ONLINE							
INDUSTRY STORY - NVIDIA's AI PC push may open opportunities for India's semicon ecosystem							
1	4th June,2026	The Hindu Business Line	NVIDIA's AI PC push may open opportunities for India's semicon ecosystem	12	Link	95000	Mr Ashok Chandak President IESA and SEMI India
ONLINE							
INDUSTRY STORY - Focus on design, packaging over wafer race							
1	1st June,2026	Times of India	Focus on design, packaging over wafer race	N/A	Link	84000	Mr Ashok Chandak President IESA and SEMI Raja Manickam, Founder iVP Semi
2	1st June,2026	MSN	Focus on design, packaging over wafer race	N/A	Link	20000	Mr Ashok Chandak President IESA and SEMI Raja Manickam, Founder iVP Semi

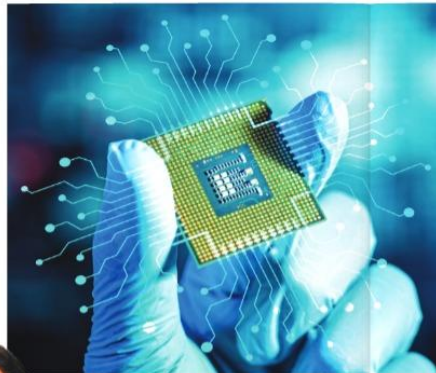
**MAGAZINE PRINT
EXCLUSIVE INTERVIEW**

Date	25th June
Publication	ET Edge Insights
Quote By	Ashok Chandak

Technology

BY TANMOY MITRA

For decades, semiconductors were largely viewed as an economic industry — critical to electronics manufacturing, but ultimately driven by cost, efficiency and scale. Today, that perception has fundamentally changed. In the AI era, “knowledge control is strategic control.” Nations that control semiconductor technology, manufacturing capability, compute infrastructure, and IP ownership will increasingly shape the global economic order.



India's semiconductor future will be built on trust, not just chips

In a world racing for chips, India is betting that trust may matter as much as scale

Ashok Chandak, President, IESA and SEMI India



Ashok Chandak

Nations that control semiconductor technology, manufacturing capabilities, computing infrastructure, and intellectual property will increasingly shape the global economic order. The pandemic, geopolitical tensions, export controls, and supply-chain disruptions have transformed the semiconductor narrative. Governments and industries are no longer thinking only about efficiency; they are thinking about resilience, trust and strategic alignment. In this changing world, India's opportunity is much larger than becoming another low-cost manufacturing destination. India can emerge as the world's “trusted semiconductor partner.”

The future semiconductor leaders will not be defined only by manufacturing scale, but by who the world trusts most.

From aspiration to execution

India's semiconductor ambitions remained largely aspirational despite becoming a global design powerhouse. That changed with the launch of the India Semiconductor Mission (ISM).

A major credit goes to the strong vision and sustained engagement of Hon'ble Prime Minister Narendra Modi and Union Minister Ashwini Vaishnaw, who elevated semiconductors into a national strategic priority and brought the sector into mainstream policy and public discourse.

What was once a highly specialised technical conversation is now part of India's national economic narrative. With over 10,000 media references and more than 200 television discussions focused on India's semiconductor ambitions, India's semiconductor momentum

is not incidental: it is the result of sustained vision, policy continuity, and leadership focus.

ISM 1.0 adopted a pragmatic approach by creating foundational capabilities through fabs, OSATs, compound semiconductors, display manufacturing, and design-linked incentives. Today India has approved 12 semiconductor projects with investments exceeding ₹1.6 lakh crore, with projects already entering production. India has demonstrated that it is READY and can DELIVER.

The proactive policy vision and execution by India Semiconductor Mission and Ministry of Electronics and Information Technology, along with strong support from multiple state governments, have acted as a major catalyst in accelerating India's semiconductor ecosystem

and transforming the sector from aspiration to execution.

The sector is now seeing strong participation from global semiconductor leaders alongside India's major industrial groups and startups. When global technology leaders and India's industrial champions invest together, ecosystems evolve faster.

Why trust has become the new global currency

The semiconductor industry historically optimised around efficiency. The next era will optimise around resilience. The world has witnessed pandemic-era chip shortages, technology tensions between countries, supply-chain vulnerabilities, and geopolitical disruptions. As a result, global

**STANDALONE INDUSTRY STORY
ONLINE**

Date	30th June
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AI is rewriting the memory chip industry. Can India build its own ecosystem?

Unnati Gusain • June 30, 2026, 15:25:50 IST



The AI boom is creating an unexpected global memory chip crunch, with consequences for smartphones, laptops and India's semiconductor ambitions. Firstpost spoke to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India, about the causes, the challenges and India's path towards building a memory ecosystem.

It is ironic how quickly fortunes have changed in the smartphone market.

Not long ago, consumers were enjoying some of the lowest smartphone prices in years, helped by oversupply, slowing demand and intense competition among brands. Today, that trend is beginning to reverse. Behind the scenes, a different battle is unfolding, one that has little to do with smartphones themselves and everything to do with artificial intelligence.

As Microsoft, Google, OpenAI, Meta and Amazon pour hundreds of billions of dollars into AI infrastructure, they are consuming enormous quantities of one of the world's most critical semiconductor components: memory chips. The consequences are already rippling through the technology industry, from smartphones and laptops to cars and industrial electronics.

AI has turned memory chips into the world's hottest commodity

Every AI model, whether it powers ChatGPT, Gemini or Claude, runs inside enormous data centres packed with thousands of specialised processors. But those processors cannot function alone. They require equally sophisticated memory chips to constantly feed them data.

Think of the processor as the brain and memory as the plate carrying its food. The faster the brain works, the more food it demands.

Today's AI servers rely heavily on High Bandwidth Memory (HBM), an advanced form of memory that stacks multiple chips vertically using sophisticated packaging technologies. The result is significantly faster performance, but also far greater manufacturing complexity.

That has fundamentally altered the economics of the memory industry.

"The current memory tightness is primarily being driven by the unprecedented growth in AI infrastructure," Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India, tells Firstpost.

According to Chandak, leading manufacturers are increasingly dedicating wafer production and advanced packaging capacity to HBM because it delivers significantly higher returns than conventional DRAM and NAND memory used in smartphones, PCs, consumer electronics and vehicles.

"This is fundamentally a capacity allocation issue rather than a technology limitation," he explained.

Unlike logic chips, memory manufacturing cannot simply be scaled up overnight. New fabrication plants cost tens of billions of dollars, require years to construct and demand highly specialised manufacturing expertise.

Even though several global expansion projects are underway, Chandak believes meaningful additional capacity will only begin arriving over the next 18 to 24 months, with the market likely remaining tight through 2026.

That aligns with recent analysis from Deutsche Bank, which described memory production as becoming a “zero-sum game”. Every silicon wafer allocated to HBM for AI servers is one less wafer available for smartphones, personal computers or automotive electronics.

This results in AI's insatiable appetite is pushing up memory costs across almost every consumer device.

Why India cannot simply start making memory chips

India has made semiconductors a strategic priority, but memory manufacturing presents perhaps the toughest challenge in the entire industry.

Unlike chip design or assembly, leading-edge DRAM and NAND fabrication requires more than capital. It demands decades of manufacturing experience, proprietary intellectual property, sophisticated process technology and massive economies of scale currently controlled by only a handful of global companies.

“Memory manufacturing is among the most capital-intensive and technologically complex segments of the semiconductor industry,” Chandak said.

A single cutting-edge memory fabrication plant can require investments exceeding US\$10-15 billion, alongside continuous technology upgrades and access to manufacturing know-how that India currently lacks.

India is quietly building the foundations of a memory ecosystem

Rather than attempting to leap directly into wafer fabrication, India is focusing on strengthening every other layer of the memory supply chain.

Micron's Advanced Testing, Assembly and Packaging (ATMP) facility in Sanand, Gujarat, marks one of the country's biggest semiconductor investments. While the memory wafers themselves are still manufactured overseas, the plant will package and test DRAM and NAND chips destined for global markets.

According to Chandak, this represents far more than an assembly operation.

It helps develop specialised talent, supplier networks, manufacturing expertise and process capabilities that will eventually support more advanced semiconductor production.

The ecosystem is expanding elsewhere too. Companies such as 3D Glass Solutions are investing in advanced glass substrates, an emerging technology expected to play an increasingly important role in packaging next-generation AI processors and high-performance memory.

"India may not yet manufacture leading-edge DRAM or NAND wafers, but it is steadily building critical capabilities across the memory value chain," Chandak said.

EXCLUSIVE INTERVIEW

ONLINE

Date	30th June
Publication	ET Electronics World
Link	https://electronics.economictimes.indiatimes.com/news/semiconductors/revamping-indias-semiconductor-landscape-insights-from-navin-bishnoi-on-ism-20/132069040

ISM 2.0 needs to boost full ecosystem creation: Navin Bishnoi

"With the ISM 2.0, there is a need to ensure that we move from design to manufacturing. We were defining design-led manufacturing and then manufacturing-led design. So, we were creating these start-ups," the executive added.

NEW DELHI: The government should look holistically to boost the entire value chain, including the supply chain ecosystem, talent pipeline, and allow incentives as it rolls out a policy roadmap for the India Semiconductor Mission (ISM) 2.0, a top industry executive said.

"The ISM 2.0 has to really expand into full end-to-end ecosystem creation. It needs to cover the whole supply chain. We need a policy in place with incentives for ecosystem creation for raw materials, minerals, chemicals, gases, steel and equipment manufacturers," Navin Bishnoi, chairman, India Electronics and Semiconductor Association (IESA) & country manager (India) at Marvell Technology, said, adding that policy support to boost talent pipeline, intellectual property (IP), and startups is needed.

Further, Bishnoi said the ecosystem should include a mix of global and local companies, with design playing an integral part in the value chain.

"India is the biggest talent creator and the owner of design pieces. Somewhere between 20-30% of design engineers are Indians in global companies. We haven't done it for our own Indian ecosystem and Indian systems. So that's where the design-led incentive (DLI) scheme came in to promote the Indian design startups."

In 2021, the Centre unveiled the Design-Linked Incentive (DLI) scheme under the Semicon India Programme, a ₹76,000-crore incentive initiative to offset disabilities in the domestic industry in semiconductor design to not only move up in the value chain but also strengthen the semiconductor chip design ecosystem in the country in line with the self-reliance ambition.

INDUSTRY STORY
PRINT

Date	26th June
Publication	The Hindu Business Line
Quote By	Ashok Chandak

Building skills & innovation key to electronics industry's \$500 billion target: Experts



(From left) Ashok Chandak, President, IESA; BS Srinivasan, Managing Partner, Viprod Electronics; Sonam Motwani, Founder and CEO, Karkhana.io; Venkatesha Babu, Resident Editor, *businessline*; and Sachin Dhruva Naik, Founder and CEO, Cuzor Labs; at a panel discussion on 'ESDM - From Vendors to Value Creators'

Our Bureau Bengaluru

India's ambition to build a \$500 billion electronics industry by 2030 presents a major opportunity for MSMEs, driven by rising domestic demand and exports.

While India still trails China in the manufacturing scale, industry stakeholders felt the focus should be on leveraging strengths in building skills, innovation, design, IP creation and problem-solving, rather than attempting to replicate China's model.

Participating in a panel discussion on 'ESDM - From Vendors to Value Creators', moderated by Venkatesha Babu, Resident Editor, *businessline*, experts pointed out that India's electronics ecosystem is still heavily dependent on imported components.

LIMITED VALUE-ADDITION
While assembly operations have expanded significantly, much of the value creation remains outside the country.

In sectors such as smartphones, India may manufacture products for global brands, but the value-addition often remains limited because a large share of components continues to come from overseas, particularly China.

"Our journey as a country is very much on track in terms of electronics manufacturing," said Ashok Chandak, President, IESA (India Electronics and Semiconductor Association). The target to build a \$500 billion electronics manufacturing industry includes \$400 billion in finished products and \$100 billion in components that will fit into it.

RISING EXPORTS
While exports from India are growing, the domestic consumption is also growing very fast, said Chandak. Beyond handsets and mobile phones, there is a huge demand emerging in industrial products, telecom, appliances, automotive electronics, defence and so on, said Chandak, exhorting the MSMEs to look beyond "Make in India".

"Make in India is already done. Got to go beyond, that is, design in India, build in India, secure in India and get trusted world wide," said Chandak.

While stating that opportunities are abundant and unfolding, Chandak said about 75 new projects have been approved under the Electronic Component Manufacturing Scheme, of which close to a third are from South India.

About 11 projects have been ap-

proved in Karnataka and 13 in Tamil Nadu.

While huge opportunity exists in electronic manufacturing, several challenges, such as shortage of skilled talent and lack of robust domestic component system, exist.

"We are in a situation where we make iPhone for the world and earn 5 per cent value of the phone," said BS Srinivasan, Managing Partner, Viprod Electronics.

"The labour productivity is one-third in India, one-fifth of China. Unless and until we get our labours to up-skill, we won't get to close to China," said Srinivasan, adding that "in the Age of AI, industry 5.0, we need to skill 100 million people in the next 5-10 years".

TECHNOLOGY READINESS

Srinivasan further stressed that there's a need to target 10,000 MSMEs and take them from "technology readiness level 3 to technology readiness level 6".

"By 2030, if we all work very hard, I think we can all have 1,500 technologies that we import made in India," he added.

"We are quite far away from becoming another China in terms of electronics manufacturing," said Sonam Motwani, Founder and CEO, Karkhana.io, adding that there are few areas where we have the ability to excel and build a strength for ourselves and build our own IP.

CHINA WAY AHEAD

Sachin Dhruva Naik, Founder & CEO, Cuzor Labs, said in terms of component ecosystem, China is a decade ahead. We should find an insight and scale rather than trying to copy China.

"If anyone of us thinking that we can compete with China by the volume of being cheaper, I personally feel it is just not the game," he said.

Date	26th June
Publication	The Hindu Business Line
Quote By	Ashok Chandak

‘India’s developed nation ambition rests on MSMEs’

Our Bureau
Bengaluru

Micro, Small and Medium Enterprises (MSMEs) will play a decisive role in determining whether India achieves its ambition of becoming a developed economy by 2047, with policy-makers and industry leaders calling for a stronger focus on innovation, design, talent and technology adoption at the fifth edition of *The Hindu businessline* MSME Growth Conclave, co-powered by Central bank of India.

Across discussions spanning manufacturing, electronics, skilling and entrepreneurship, a common theme emerged: India can no longer rely solely on low-cost production and must move up the value chain.

DESIGN SHIFT

Setting the tone for the conclave, Karnataka Minister for

Medical Education and Skill Development, Sharanaprakash Rudrappa Patil, urged businesses to think beyond manufacturing.

“We should move from ‘Made in India’ to ‘Designed, Engineered and Owned in India,’” he said.

MSMEs would determine whether the country becomes a global innovation hub or merely the world’s factory floor, he added.

GROWTH ENGINE

Addressing the forum, BV Naidu, Chairman of the Karnataka Digital Economy Mission (KDEM), said India is on track to become a \$32 trillion economy by 2047, but warned that achieving the developed nation status would require a substantial rise in per capita income. He argued that MSMEs would play an even greater role than large enterprises in driving economic growth because of their agility and abil-



Sharanaprakash Rudrappa Patil, Karnataka Minister for Medical Education and Skill Development at the event. BUJOY SHOSH

ity to innovate. Naidu also highlighted the growing importance of the digital economy, noting that Karnataka’s digital sector contributes 35-40 per cent of the State’s economy.

He said government support in areas such as market access, infrastructure, financing and talent development would be crucial, particularly as smaller firms grapple with

the rapid adoption of AI. That sentiment echoed through the electronics manufacturing panel, where speakers argued that India should focus on building IP and specialised capabilities rather than attempting to replicate China’s manufacturing model.

ELECTRONIC MANUFACTURE

Ashok Chandak, President of IESA and SEMI India, said opportunities in electronics manufacturing are expanding rapidly across sectors ranging from telecom and industrial equipment to automotive and defence. “Make in India is already done. Got to go beyond, that is, design in India, build in India, secure in India and get trusted worldwide,” he said.

However, on an optimistic note, Milky Mist Chairman and Managing Director Satish Kumar T, urged entrepreneurs to think bigger.

“Most of the time, entrepreneurs are underestimating India. It is an enormous opportunity,” he said.

The Associate Partners for the conclave are Bank of Baroda, Tally, Punjab National Bank, SSVM Institutions, Canara Bank, Kerala Bureau of Industrial Promotion (K-BIP), Karnataka Bank, Karnataka Power Corporation Ltd, Department of Industries – Government of Bihar, Indian Overseas Bank, Mysore Sales International Ltd and Karnataka Cooperative Milk Producers’ Federation Limited.

The Luxury Realty Partner is Puravankara, and the education partner is Presidency University, while the SUV partner is Mahindra.

The State partner is the RAMP Programme (supported by the Government of India and the World Bank, and implemented by the Government of Karnataka).

DELHI

Date	26th June
Publication	The Hindu
Quote By	Ashok Chandak

'MSMEs must lead India's innovation push to achieve Viksit Bharat goal'

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Addressing the forum, B.V. Naidu, chairman of the Karnataka Digital Economy Mission (KDEM), said India is on track to become a \$32 trillion economy by 2047, but warned that achieving developed nation status would require a substantial rise in per-capita income. He argued that MSMEs would play an even greater role than large enterprises in driving economic growth because of their agility and ability to



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Focus on IP

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Talent and productivity emerged as another key concern. Industry leaders highlighted the widening gap between academic curricula and industry requirements and stressed on the need for closer collaboration between educational institutions and businesses. Several speakers also pointed to artificial intelligence as a force multiplier that could help

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"I think it's very important to have the people strategy or the people design, from where you're going to get people, what skills are required, and companies need to go down and collaborate with institutions," said Nitin Dave, CEO, Staffing Solution, Qness Corp.

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INDUSTRY STORY
PRINT BANGALORE

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businessline's MSME meet starts today

BL Bureau
HYDERABAD

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World MSME Day takes place globally every June 27. The event celebrates small businesses, showcases their economic contributions, and advocates for their sustainable growth.

The first event at Bengaluru, co-powered by the Central Bank of India, will feature two power-packed



panel discussions – one on ‘ESDM - From Vendors to Value Creators’ and the other on ‘Talent Skilling and Labour Challenges’ – and a fireside chat.

At the Bengaluru Conclave, Sharanaprakash Rudrappa Patil, Minister for Medical Education and Skill Development of Karnataka, will be the Chief Guest. The guest of honour is B.V. Naidu, chair-

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The second panel on ‘Talent Skilling and Labour Challenges’ will have Rakesh Patil, Co-Founder and CTO, Beyond Appliances; Kartik Narayan, CEO, Apna Co; Nitin Dave, CEO, Staffing Solutions, Qness Corp;

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The second panel on ‘Talent Skilling and Labour Challenges’ will have Rakesh Patil, Co-Founder and CTO, Beyond Appliances; Kartik Narayan, CEO, Apna Co; Nitin Dave, CEO, Staffing Solutions, Qness Corp;

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The fireside chat with Satish Kumar T, Chairman & Managing Director, Milky Mist will be hosted by Raghuvir Srinivasan, Editor, *The Hindu businessline*. The past four years too, on MSME Day, *businessline* had hosted similar conclaves for MSMEs, which saw the participation of many from the sector. These enterprises play a vital role in the Indian economy.



INDUSTRY STORY
PRINT CHENNAI

Date	25th June
Publication	The Hindu
Quote By	Ashok Chandak

businessline's MSME meet starts today

BL Bureau
HYDERABAD

To honour the achievements of micro, small and medium enterprises, businessline is organising its fifth annual MSME Conclave in Bengaluru on June 25 and Coimbatore on June 27. The two-city event will highlight the sector's crucial role in India's economic development.

World MSME Day takes place globally every June 27. The event celebrates small businesses, showcases their economic contributions, and advocates for their sustainable growth.

The first event at Bengaluru, co-powered by the Central Bank of India, will feature two power-packed



panel discussions – one on ‘ESDM - From Vendors to Value Creators’ and the other on ‘Talent Skilling and Labour Challenges’ – and a fireside chat.

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**MAGAZINE PRINT - PANEL DISCUSSION
INDUSTRY STORY**

Date	3rd June
Publication	Forbes
Quote By	Ashok Chandak



Reimagining India's Workforce and Workspaces

From AI and geopolitics to grassroots entrepreneurship and sustainable workspaces, the Future of Work Summit 2026 mapped the changing world of work.



Harish Upadhyaya, CNN-News18 in conversation with D. K. Shivakumar, Deputy Chief Minister of Karnataka



Chandra R Srikanth Executive Editor-Technology and Startups, Moneycontrol in conversation with Dr. N. Manjula (IAS), Secretary of the Department of Electronics, Information Technology (IT), Biotechnology (BT), and Science & Technology for the Government of Karnataka and Lohit Bhatia, CEO, Qess Corp.

The future of work is unfolding in real time—defined by AI-led transformation, evolving workforce expectations, geopolitical realignments, distributed talent ecosystems and a fundamental rethink of the workplace itself. These shifts formed the core of conversations at the Future of Work Summit 2026, an initiative by Network18 presented by IndiQube, recently held in Bengaluru.

Bringing together policymakers, founders, diplomats, entrepreneurs and business leaders, the summit explored how India can prepare for a future where work is increasingly fluid, skills are the new currency and workplaces must evolve beyond physical infrastructure into ecosystems of productivity, collaboration and belonging.

Convergence of Work, Workforce and Workspace

Setting the tone for the evening, Rishi Das, Co-founder and CEO of IndiQube, observed that the key challenge now is designing organizations, workplaces and ecosystems that enable people to do their best work in a world changing faster than ever—making the convergence of work, workforce and workplaces more important than ever before.

“When we discuss the future of work, we are no longer just discussing offices. We are talking about the future of enterprises, talent, cities, technology, and in many ways, the future of India’s economic ambitions,” he emphasized.

He pointed out that India is approaching a defining moment where it must evolve from being merely a global talent destination into a global workplace



D. K. Shivakumar, Deputy Chief Minister of Karnataka

innovation destination. Drawing from IndiQube’s own journey to building a presence in 17 cities, comprising nearly 10 million square feet of managed workspace, which serves all genres of enterprise from startups and GCCs to Fortune 500 companies, he highlighted how work is increasingly moving closer to where people are, unlocking new possibilities beyond traditional urban clusters.

Karnataka’s Innovation Ecosystems

That theme of India’s next leap resonated strongly through the summit, particularly in the conversations around Karnataka’s role in shaping the future economy. Karnataka Deputy Chief Minister D. K. Shivakumar described Bengaluru as “the city of the future,” reflecting on how the state had successfully captured both the PSU and IT booms and was now preparing for its next phase of growth.

He pointed to Bengaluru’s deep technology ecosystem, global business presence and talent density as critical

advantages at a time when AI and digital transformation are rapidly redefining industries. Even while acknowledging concerns around AI-led job disruption, Shivakumar maintained that Karnataka’s innovation ecosystem would continue to position it at the forefront of the future economy.

That confidence was echoed by Dr. N. Manjula (IAS), Secretary, Department of Electronics, IT, Biotechnology and Science & Technology, Government of Karnataka, who highlighted the state’s emergence as a global AI and innovation hub. Bengaluru today hosts more than half of India’s AI engineers and has added over 135 Global Capability Centres (GCCs) in the last two years alone.

Employability in the Age of AI and Gig Work

The summit also made it clear that the future of work cannot be viewed solely through the lens of technology adoption. Employability itself is changing. Lohit Bhatia, CEO of Qess Corp, described the rise of gig work, quick commerce and app-driven employment models as a



Rishi Das, CEO, IndiQube and Shashank Mani, Entrepreneur, Member of Parliament (Deoria Lok Sabha)

structural shift rather than a temporary trend. He pointed to the rapid expansion of hyperlocal services and digital-first workforce platforms as evidence of how consumer behaviour and employment expectations are evolving simultaneously.

Pushing back against the increasingly common narrative of 'jobless growth', he pointed out that India's demographic realities make its future fundamentally different from ageing economies where AI is increasingly replacing labour due to workforce shortages. "India should still remember that human and technology is the best confluence that we can have," he added.

That convergence between humans and technology emerged repeatedly throughout the summit, particularly during discussions around AI adoption. Kaivalya Vohra, Co-founder of Zepto, revealed how AI is already influencing nearly every function within fast-growing companies—from engineering and customer support to product development and internal workflows. Perhaps more significantly, AI is beginning to democratise creation itself.

Talent, Trade and the New Geopolitics of Work

The summit also examined the geopolitical dimensions of talent and work. In a discussion on 'Geopolitics@Work: The Great Global Talent Divide', Chandru Iyer, British Deputy High Commissioner to Karnataka, reflected on the evolving India-UK relationship following the recently concluded Free Trade Agreement.

What stood out in his remarks was the idea of "talent circulation" replacing simple talent migration. The future, according to Iyer, lies not merely in moving workers across borders, but in building interconnected ecosystems of education, business and opportunity where global career pathways can emerge locally. "This is the new geopolitical talent strategy," he said.



M. B. Patil, Minister for Large & Medium Industries and Infrastructure Development, Government of Karnataka

The Human Edge In An AI-First World



Rohit Choudhary, Co-founder & CEO, Seekho; Prateek Dixit, Co-founder, Pocket FM; Kaivalya Vohra, Co-founder, Zepto in conversation with Tushar Goenka, Moneycontrol



Anil Ethanur, Co-founder, Xoheno; Chandru Iyer, British Deputy High Commissioner to Karnataka and His Majesty's Deputy Trade Commissioner for Investment, South Asia; Ashok Chandak, CEO & President, India Electronics and Semiconductor Association and SEMI India; Rency Mathew, MD - India Centre and People Leader (APAC ANZ), Sabre Corporation; GNV Subba Rao, Whole-time Director, ABB GISPL in conversation with Bhavya Dilipkumar, Moneycontrol



Rishi Das, CEO, IndiQube; Ravindra Pai, MD, Century Real Estate and Ar V. Nareesh Narasimhan, Managing Partner, Venkataramanan Associates in conversation with Chandra R Srikanth, Executive Editor - Technology and Startups, Moneycontrol

At the same time, speakers repeatedly emphasized that the future economy will demand continuous learning. One of the sharpest observations of the evening was: AI is not why you are losing your job. You are losing your job because you are not upskilling.

Grassroots Entrepreneurship and Inclusive Growth

A compelling intervention came from Shashank Mani, Entrepreneur and Member of Parliament from Deoria Lok Sabha constituency, who argued that the future of work cannot be built in metros alone. He spoke about entrepreneurship as a bridge between urban innovation and grassroots transformation and urged audiences to think about AI not just as a productivity tool, but as a means of releasing human potential. "If you do not have an inclusive growth formula, we will not succeed in creating Viksit Bharat," he opined.

Purpose of the Workplace in a Changing World

The summit concluded by turning attention toward the physical workplace itself. As hybrid work continues to redefine employee expectations, panelists argued that offices must now do far more than simply provide desks and amenities. Future-ready workplaces must inspire collaboration, reduce friction, support well-being and integrate more deeply with urban life itself.

The essence of the summit was that the future of work is no longer about isolated conversations around offices, AI or hiring. It is about designing systems—economic, technological and human—that allow people and enterprises to thrive together in a rapidly changing world. As the Co-Founder and CEO of IndiQube, Rishi Das, noted, "The future of work will not be shaped by technology alone. It will be shaped by people willing to think ahead and build with intent."

**ONLINE
INDUSTRY STORY**

Date	4th June
Publication	The Hindu Business Line
Link	https://www.thehindubusinessline.com/info-tech/nvidias-ai-pc-push-may-open-opportunities-for-indias-semicon-ecosystem/article71062038.ece

Nvidia's AI PC push likely to open up opportunities for semicon ecosystem

Sanjana B
Bengaluru

Nvidia is seeking to reshape the PC industry with an AI-first chip architecture, a shift that experts say could strengthen India's role in the global AI and semiconductor value chain.

The chipmaker giant, on Monday, unveiled the RTX Spark, a new superchip that "reinvents Windows PCs for the era of personal AI agents".

"The PC is being reinvented," said Jensen Huang, founder and CEO of Nvidia, describing RTX Spark as a platform built for local AI agents, creative workflows, and gaming.

MediaTek, a market leader in Arm-based system-on-a-chip designs, collaborated with Nvidia on the custom CPU design.

MAJOR IMPLICATIONS

"For many years, Intel and AMD have dominated their markets. Meanwhile, Nvidia has transformed the AI industry in five years. Huang's claim that Nvidia is reinventing the PC triggered a sell-off across leading PC chip stocks, with the industry working to understand the larger implications," said Omprakash Subbarao, CEO of CORE Labs, FSID.

While Intel and AMD have



largely added AI capabilities to their usual chips, Nvidia has designed its chip from the ground up with AI at the core, equipping it with substantial memory to enable large AI models to run directly on the laptop rather than depending on the Internet, explained Prof Sanket Goel, Chair Professor, BITS Pilani, and Head of CREST. In essence, Nvidia is building its chip around the AI engine, treating it as the heart of the machine.

To date, most Windows laptops run on Intel or AMD chips. Nvidia now gives the laptop makers a third choice. The RTX Spark will be included in a new line of Windows PCs made by Lenovo, HP, Dell, Microsoft Surface, Asus and MSI. Models from Acer and Gigabyte to follow.

Ashok Chandak, President of IESA and SEMI India, argued that while Intel and AMD will continue to dominate mainstream PCs, Nvidia

is well-positioned in premium AI PCs by leveraging its strengths in AI software, GPUs, and accelerated computing. The move may not disrupt the market overnight, but it will intensify competition in AI-enabled computing.

Moreover, the increasing demand for AI-enabled computing is expected to drive the need for hardware platforms that deliver superior performance and greater energy efficiency.

"With more global attention being paid to the development of computing and AI-driven technology, there are many opportunities for the semiconductor industry chain. Such a trend may lead to further investment into production, testing, packaging, research, and innovation in this field," Rajeev Gautam, President, HORIBA India, shared.

DEMAND SURGE

The IESA President believes that with AI PCs expected to boost demand for advanced chips, software, system design, testing, packaging, and electronics manufacturing, India is well-positioned to participate through its strengths in chip design, embedded software, AI development, product engineering, and semiconductor R&D, with the bigger opportunity lying in contributing to the

global AI-PC ecosystem rather than manufacturing AI processors domestically.

However, the main challenge is market adoption. Given the country's price-sensitive PC market, premium AI PCs are likely to remain a niche segment initially.

Chandak noted that while AI PCs are expected to become mainstream by 2030, accounting for an estimated 250-300 million units out of a total PC market of 280-320 million units, Nvidia-class premium AI PCs are likely to remain a niche segment. The category may ship around 20-40 million units annually, serving developers, engineers, designers, and other users with advanced computing requirements rather than the mass market.

"As per my estimate, only about 7-15 per cent of global PCs by 2030 will require Nvidia-class local AI compute. India currently accounts for about 18-22 million PC shipments annually, representing roughly 6-8 per cent of global demand. The premium PC segment is driven largely by enterprise purchases."

Looking ahead to 2030, he estimates that traditional PCs will account for 15-20 per cent of India's PC market, while mainstream AI PCs could make up 70-80 per cent

PRINT
INDUSTRY STORY

Date	1st June
Publication	The Times Of India
Quote By	Ashok Chandak

‘Focus on design, packaging over wafer race’

Vaitheeswaran.B
@timesofindia.com

Chennai: India should focus on its current strengths and aim for global leadership on design, outsourced semiconductor assembly and testing (OSAT), advanced packaging, and critical semiconductor materials, including wide bandgap and advanced packaging materials, rather than chasing the wafer race, according to a NITI Aayog report released on Friday.

The report argued that it should prioritise capital allocation and talent based on strategic importance and global value chain integration, contrasting with the govt' rhetoric and stated goal of ISM 2.0, announced in February, which included a roadmap for advanced manufacturing of 3 and 2 nanometre technology nodes.

NITI Aayog recommends

pivoting away from continuing the catch-up game in the foundry race and focusing on advanced packaging, system integration and manufacturing scale, which matter as much as transistor nodes in the current era. It added that the country should be prag-

...said a NITI Aayog report, adding that India should prioritise capital allocation & talent based on strategic importance

matic and selective in advanced technology nodes. Mature-node logic, speciality analogue and mixed-signal chips and compound semiconductors such as Silicon Carbide (SiC) and Gallium Nitride (GaN), which power India's industrial and strategic sectors, matter most to India's economy, it said.

Raja Manickam, founder of iVP Semi, said India should focus on well-defined, high-value, mature foundational semiconductor products rather than cutting-edge products.

“Power semiconductors, simple logic, and catalogue chips are easier to design and manufacture, have strong existing demand, and can be produced in fabs with a comparatively lower capex, with roughly \$400-\$500 million. Foundational chips can generate large volumes, which helps India learn manufacturing at scale and attracts the supporting ecosystem, such as equipment makers, chemicals, materials suppliers, etc.,” he said, adding, “Treat advanced node goals as longer-term after foundational capacity is established and use incentives strategically to develop domestic, non-Chinese equip-

ment ecosystems in the country, he added.

Ashok Chandak, president of IESA and SEMI India, said India should focus on areas where it can compete today while continuing to invest in future capabilities. While design, packaging and mature-node segments can deliver near-term global relevance, he said India should avoid creating an artificial distinction between mature nodes and advanced technologies, as a successful semiconductor ecosystem requires both. Countries leading in advanced-node manufacturing have built their capabilities over decades, and India must continue investing in R&D, process technologies, pilot lines and future-node readiness, he added.

The report argues that India should target \$120-150 bn in the semiconductor value chain by 2035.

INDUSTRY STORY
STORY

Date	12th June
Publication	Deccan Chronicle
Quote By	Ashok Chandak

Rising memory, PCBs costs may hurt electronic devices

SANGEETHA G.
CHENNAI, JUNE 12

Electronic devices and appliances are expected to become 10-25 per cent costlier over the next year as rising prices of memory, printed circuit boards (PCBs) and other key components increase manufacturing costs, according to industry estimates.

The sector has already witnessed price increases as inputs such as memory components, PCUs, PCBs and display-related items become more expensive due to Chinese restrictions on rare earth magnets and strong global demand driven by artificial intelligence (AI).

Electronic product costs are largely determined by semiconductors, memory and other components.

“Memory prices have already risen significantly because of global AI-driven demand,” said Ashok



Chandak, president of the India Electronics and Semiconductor Association (IESA).

He said many suppliers were diverting capacity towards high-bandwidth memory, affecting the availability and pricing of conventional memory products such as DRAM and flash memory. This has already impacted smartphones, laptops and household appliances.

PCB costs have also increased because of raw material shortages and higher input prices. Combined with rising

costs of other components, this could push up prices of electronic products by 10-25 per cent.

Some price increases have already been implemented, and products could become another 10-25 per cent more expensive over the next year, depending on the category. The impact is likely to be higher for smartphones, energy meters and electronics-intensive appliances than for washing machines and refrigerators and similar ones.

Chandak also pointed to vulnerabilities in the display manufacturing supply chain.

He said India's display manufacturing ecosystem is unlikely to expand significantly over the next 12-18 months, with only one major project approved recently and most existing activity focused on display assembly rather than fabrication.

INDUSTRY STORY
ONLINE - HBL EVENT

Date	26th June
Publication	The Hindu Business Line
Link	https://www.thehindubusinessline.com/companies/building-skills-innovation-hold-the-key-to-indias-500-billion-electronic-industry-target-by-2030/article71147034.ece

COMPANIES

businessline MSME Conclave. Building skills, innovation hold the key to India's \$500 billion electronic industry target by 2030

Experts pointed out that India's electronics ecosystem is still heavily dependent on imported components

By Our Bureau

Updated - June 25, 2026 at 10:16 PM | Bengaluru

GIFT THIS ARTICLE



(from left to right) Ashok Chandak, President, IESA; BS Srinivasan, Managing Partner, Viprof Electronics; Sonam Motwani, Founder and CEO, Karbhonika; Venkatesha Babu, Resident Editor, businessline, and Sachin Dibrava Naik, Founder and CEO, Cuzer Labs, at a panel discussion on ESDM - From Vendors to Value Creators | Photo Credit: Bijoy Ghosh

India's ambition to build a \$500 billion electronics industry by 2030 presents a major opportunity for MSMEs, driven by rising domestic demand and exports. While India still trails China in the manufacturing scale, industry stakeholders felt the focus should be on leveraging strengths in building skills, innovation, design, IP creation and problem-solving, rather than attempting to replicate China's model.



Participating in a panel discussion on ESDM -

From Vendors to Value Creators at conclave, experts pointed out that India's electronics ecosystem is still heavily dependent on imported components.

While assembly operations have expanded significantly, much of the value creation remains outside the country. In sectors such as smartphones, India may manufacture products for global brands, but the value addition often remains limited because a large share of components continues to come from overseas, particularly China.

"Our journey as a country is very much on track in terms of electronics manufacturing" said Ashok Chandak, President, IESA (India Electronics and Semiconductor Association). The target to build a \$500 billion electronics manufacturing industry includes \$400 billion in finished products and \$100 billion in components that will fit into it.

Date	26th June
Publication	Silicon India
Link	https://www.thehindubusinessline.com/companies/building-skills-innovation-hold-the-key-to-indias-500-billion-electronic-industry-target-by-2030/article71147034.ece

MSMEs must lead Innovation Push for Viksit Bharat goal says Dr Sharan Prakash Patil

By [siliconindia](#) | Friday, 26 June 2026, 08:39:36 AM IST



Synopsis

Dr Sharan Prakash Patil said MSMEs must lead innovation to realize the Viksit Bharat goal, highlighting their role in job creation, technology adoption and inclusive growth. He called for stronger policy backing, skilling initiatives and digital transformation to make MSMEs globally competitive. [Doctors' Offices](#)

India's MSMEs are expected to play a decisive role in shaping whether the country achieves its ambition of becoming a developed economy by 2047, as policymakers and industry leaders emphasized at the fifth edition of The Hindu businessline MSME Growth Conclave in Karnataka. The discussions underscored that India's growth story will depend not just on scale but on innovation, design thinking, talent development, and **accelerated technology adoption**, especially as global competition intensifies and the nation aims to move up the value chain.

Setting the tone, **Karnataka Minister for Medical Education and Skill Development Dr Sharan Prakash Patil** emphasized a shift in mindset for Indian MSMEs, stating, "We should move from 'Made in India' to 'Designed, Engineered and Owned in India'", highlighting the need to build globally competitive intellectual capability rather than focusing solely on manufacturing output.

BV Naidu, Chairman of the Karnataka Digital Economy Mission, says India is on track to become a \$32 trillion economy by 2047, but stressed that achieving developed nation status would require a significant rise in per capita income. He added that MSMEs will likely outpace large enterprises in driving growth due to their agility and innovation potential. He also pointed to the **expanding digital economy** in Karnataka, noting that the state's tech sector contributes between 35% and 40% of its economy, while calling for stronger government support in financing, market access, infrastructure, and talent ecosystems, particularly as firms **adopt artificial intelligence (AI)**.

In the electronics manufacturing session, experts argued that India must prioritize building intellectual property (IP) and specialized capabilities rather than trying to replicate China's cost-driven manufacturing model. **Sachin Dhruva Naik, founder and CEO of Cuzor Labs**, says, "If anyone thinks we can compete with China by being cheaper, it is not the game", emphasizing differentiation through innovation. **Sonam Motwani of Karkhana.io** noted that while India has significant potential, it still trails China in scale, and must focus on niche manufacturing strengths and proprietary technologies.

Also Read: [Can Lower Oil Prices Spark the Next Growth Cycle for India's MSMEs?](#)

Ashok Chandak, president of IESA and SEMI India, said opportunities in electronics manufacturing in India are expanding across telecom, automotive, industrial, and defense sectors. "Make in India is already done. Got to go beyond, that is, design in India, build in India, secure in India and get trusted worldwide", he says, reinforcing the need to evolve the Make in India initiative.

**INDUSTRY STORY
ONLINE**

Date	13th June
Publication	Deccan Chronicle
Link	https://www.deccanchronicle.com/business/prices-of-electronic-devices-appliances-to-go-up-1025-pc-on-supply-worries-1963126

Prices of Electronic Devices, Appliances To Go Up 10–25 PC on Supply Worries

Business

 Sangeetha G

12 June 2025 6:49 PM

India is particularly getting impacted in products such as speakers, microphones, motors, camera actuators, industrial automation systems, infrastructure equipment and power electronics.



Ashok Chandak President, India Electronics and Semiconductor Association (IESA). (DC)



Chennai: Electronic devices and appliances have already seen price hikes as some inputs, including memory components, PCU, PCB, and display items, become costlier due to Chinese curbs on rare earth magnets and AI-related demand. The industry expects prices to further go up by 10-25 per cent in the short to medium term. In an interview, Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), discusses the impact of China's export curbs and investment restrictions on India's electronics manufacturing sector.  Geographic Reference



Similar Posts



INDUSTRY STORY

PRINT BHUBANESWAR

Quote - Record Global Semiconductor Equipment

Date	12th June
Publication	Samaya
Quote By	Ashok Chandak

ସେମିକଣ୍ଡକୂର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ

ଭୁବନେଶ୍ୱର (ସବୁ୍ୟ): ବିଶ୍ୱ ସେମିକଣ୍ଡକୂର ଉପକରଣ ବିଳି ୨୦୨୨ ର ପ୍ରଥମ ତ୍ରିମାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକୂର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି। ସେମିର ଖର୍ଚ୍ଚାଘାତ ସେମିକଣ୍ଡକୂର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଳି ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି, ଯାହା ମୁଖ୍ୟତଃ କୃତ୍ରିମ ବୁଦ୍ଧିମତା (ଏଆଇ), ଉନ୍ନତ ଲଜିକ୍, ଡ୍ରାମ ମେମୋରୀ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରୁ ଚାହିଦାକୁ ବୃଦ୍ଧି କରି ପରିଚାଳିତ ହୋଇଛି। ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଟା କହିଛନ୍ତି, "୨୦୨୨ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ ସେମିକଣ୍ଡକୂର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିଡିଓଫିରେ ନିରନ୍ତର ଶିକ୍ଷା ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି। ରେକର୍ଡ ପ୍ରଥମ ତ୍ରିମାସିକ ବିଳି ଅଗ୍ରଣୀ ଉତ୍ପାଦନ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଚାଲୁଥିବା ଗତିକୁ ଉଜ୍ଜ୍ୱଳ କରିଛି।" ରେକର୍ଡ ଖର୍ଚ୍ଚ ଦୀର୍ଘକାଳୀନ ସେମିକଣ୍ଡକୂର ଚାହିଦା ପ୍ରତି ଶିକ୍ଷର ବିଶ୍ୱାସକୁ ଅଙ୍କିତ କରିଛି ଏବଂ ବିଶ୍ୱବ୍ୟାପୀ ଉତ୍ପାଦନ କ୍ଷମତାର ନିରନ୍ତର ପ୍ରସାରଣକୁ ସଙ୍କେତ ଦିଏ। ଖାପର ଫେବ୍ରିକେସନ୍, ପ୍ୟାକେଜିଂ, ପରାକ୍ଷଣ ଏବଂ ସେମିକଣ୍ଡକୂର ଉପକରଣରେ ବର୍ଦ୍ଧିତ ନିବେଶ ଯୋଗାଣ ଶିଖିଳକୁ ସୁଦୃଢ଼ କରିବ ଏବଂ ବିଶ୍ୱବ୍ୟାପୀ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନବସୃଜନକୁ ବୃଦ୍ଧି କରିବ ବୋଲି ଆଶା କରାଯାଉଛି।

Date	12th June
Publication	Amruta Dunia
Quote By	Ashok Chandak

ସେମିକଣ୍ଠକୂର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ-ନେଚୁରାଧୀନ ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଉଛି; ଭାରତକୁ ପାଇଦା ମିଳିପାରିବ

କୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଠକୂର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ଟ୍ରେନାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଠକୂର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିର

ଝାଲୁଝାଲତ୍ ସେମିକଣ୍ଠକୂର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଟା କହିଛନ୍ତି, '୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ

ସେମିକଣ୍ଠକୂର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିତ୍ତିଭୂମିରେ ନିର'ର ଶିକ୍ଷା ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ ସେମିକଣ୍ଠକୂର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିତ୍ତିଭୂମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ

ସେମିକଣ୍ଠକୂର ଚିକାଗନ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି ।

Date	12th June
Publication	Biswabani
Quote By	Ashok Chandak

Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit

Bhubaneswar : Global semiconductor equipment billings reached a record US\$36.55 billion in the first quarter of 2026, reflecting continued investments in semiconductor manufacturing capacity and technology upgrades worldwide. According to SEMI's Worldwide Semiconductor Equipment Market Statistics (WWSEMS) report, equipment billings grew 14% year-on-year, driven largely by accelerating demand from artificial intelligence (AI), advanced logic, DRAM memory, and advanced packaging

technologies. Commenting on the report, Ajit Manocha, President and CEO of SEMI, said, "The strong start to 2026 reflects continued industry investment in the capacity and infrastructure needed to support AI-driven semiconductor growth. With the foundation being created through the India Semiconductor Mission and the expected next phase of policy support, India can emerge as a significant hub for semiconductor design, advanced packaging, manufacturing, supply chain and ecosystem development. Said, Ashok Chandak, President SEMI India and IESA.

Date	12th June
Publication	Desbarta
Quote By	Ashok Chandak

ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ-ନେତୃତ୍ୱାଧୀନ ଦୃଷ୍ଟିର ସଙ୍କୋଚ ଦେଉଛି; ଭାରତକୁ ଫାଇଦା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ଟ୍ରେମାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକ୍ୱର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିର ଡ୍ୱାଲୁଡ୍ୱାଇଡ୍ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ

ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଟା କହିଛନ୍ତି, '୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ ସେମିକଣ୍ଡକ୍ୱର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିଡିଓମିରେ ନିରଂର ଶିଳ୍ପ ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା

ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିଡିଓମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ଡିଜାଇନ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି ।

Date	12th June
Publication	Dharitri
Quote By	Ashok Chandak

ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ
ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ-ନେତୃତ୍ୱାଧୀନ
ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଉଛି; ଭାରତକୁ
ଫାଇଦା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ଟ୍ରେମାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକ୍ୱର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିର ଡ୍ରାଲ୍ଡ୍ୱାଇଡ୍ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋତା କହିଛନ୍ତି, ‘୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଲିତ ସେମିକଣ୍ଡକ୍ୱର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିଡିଓମିରେ ନିର୍ମାଣ ଶିଳ୍ପ ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିଡିଓମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ଡିଜାଇନ, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି ।

Date	12th June
Publication	Kalinga Mail
Quote By	Ashok Chandak

ସେମିକଣ୍ଡକ୍ଟର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ-ନେତୃତ୍ୱାଧୀନ ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଉଛି; ଭାରତକୁ ପାଇଦା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଡକ୍ଟର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ତ୍ରିମାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକ୍ଟର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିର ଡ୍ୱାଲ୍ଡ଼ିଓଇଡ୍ ସେମିକଣ୍ଡକ୍ଟର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଟା କହିଛନ୍ତି, ‘୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ ସେମିକଣ୍ଡକ୍ଟର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିଡିଓମିରେ ନିର’ର ଶିକ୍ଷା ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ ସେମିକଣ୍ଡକ୍ଟର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିଡିଓମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଡକ୍ଟର ଡିଜାଇନ, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି ।

Date	12th June
Publication	Mallahar
Quote By	Ashok Chandak

ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ-ନେତୃତ୍ୱାଧୀନ ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଉଛି; ଭାରତକୁ ଫାଇଦା ମିଳିପାରିବ

ନୂଆଦିଲ୍ଲୀ: ବିଶ୍ୱ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବିଲି ୨୦୨୬ ର ପ୍ରଥମ ଡ୍ରେମାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକ୍ୱର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିର ଡ୍ୱାଲ୍ଡ଼ିଓଇଡ୍ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲି ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି, ଯାହା ମୁଖ୍ୟତଃ କୃତ୍ରିମ ବୁଦ୍ଧିମତା (ଏଆଇ), ଉନ୍ନତ ଲଜିକ, ଡ୍ରାମା ମେମୋରୀ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରୁ ଚାହିଦାକୁ ଉତ୍ତରାଦିତ କରି ପରିଚାଳିତ ହୋଇଛି ।

ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଟା କହିଛନ୍ତି, ‘୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ ସେମିକଣ୍ଡକ୍ୱର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିଡିଓରେ ନିରନ୍ତର ଶିଳ୍ପ ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ରେକର୍ଡ ପ୍ରଥମ ଡ୍ରେମାସିକ ବିଲି ଅଗ୍ରଣୀ ଉତ୍ପାଦନ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଚାଲୁଥିବା ଗତିକୁ ଉତ୍ତର କରୁଛି ।’

ରେକର୍ଡ ଖର୍ଚ୍ଚ ଦୀର୍ଘକାଳୀନ ସେମିକଣ୍ଡକ୍ୱର ଚାହିଦା ପ୍ରତି ଶିଳ୍ପର ବିଶ୍ୱାସକୁ ଅଜିତ କରୁଛି

ଏବଂ ବିଶ୍ୱବ୍ୟାପୀ ଉତ୍ପାଦନ କ୍ଷମତାର ନିରନ୍ତର ପ୍ରସାରଣକୁ ସଙ୍କେତ ଦିଏ । ଡ୍ୱାଫର ଫେବ୍ରିକେସନ, ପ୍ୟାକେଜିଂ, ପରାକ୍ଷଣ ଏବଂ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣରେ ବର୍ଦ୍ଧିତ ନିବେଶ ଯୋଗାଣ ଶୃଙ୍ଖଳକୁ ସୁଦୃଢ଼ କରିବ ଏବଂ ବିଶ୍ୱବ୍ୟାପୀ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନବସୃଜନକୁ ଉତ୍ତରାଦିତ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି ।

ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ଅଭିବୃଦ୍ଧିର ଏହି ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟରେ ଅଂଶଗ୍ରହଣ କରିବା ପାଇଁ ସକ୍ରିୟ ଭାବରେ ନିଜକୁ ସ୍ଥିତି ପ୍ରଦାନ କରୁଛି । ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ମିଶନ (ଆଇଏସଏମ) ଅଧୀନରେ, ସେମିକଣ୍ଡକ୍ୱର ଫେବ୍ରିକେସନ, ଏଟିଏମପି/ଓଏସଏଟି, ପ୍ରଦର୍ଶନ ଉତ୍ପାଦନ ଏବଂ ଉତ୍ପାଦନ ଇକୋସିଷ୍ଟମରେ ୧୨ଟି ସେମିକଣ୍ଡକ୍ୱର ଏବଂ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନ ପ୍ରକଳ୍ପକୁ ଅନୁମୋଦନ କରାଯାଇଛି । ପ୍ରତୀକ୍ଷିତ ଆଇଏସଏମ ୨.୦ କାର୍ଯ୍ୟକ୍ରମ ସେମିକଣ୍ଡକ୍ୱର ଉତ୍ପାଦନ, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସାମଗ୍ରୀ, ଉପକରଣ ଏବଂ ଡିଜାଇନ୍ କ୍ଷେତ୍ରରେ ଭାରତର କ୍ଷମତାକୁ ଆହୁରି ସୁଦୃଢ଼ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି, ଯାହା ଦେଶକୁ ବର୍ଦ୍ଧିତ ବିଶ୍ୱ ସେମିକଣ୍ଡକ୍ୱର ମୂଲ୍ୟ ଶୃଙ୍ଖଳର ଏକ ବୃହତ ଅଂଶ ଦଖଲ କରିବାରେ ସାହାଯ୍ୟ କରିବ ।

‘ବିଶ୍ୱବ୍ୟାପୀ ରେକର୍ଡ ପରିମାଣର ସେମିକଣ୍ଡକ୍ୱର

ଉପକରଣ ଖର୍ଚ୍ଚ ଇଓ, ଉଚ୍ଚ-ପ୍ରଦର୍ଶିତ କମ୍ପ୍ୟୁଟିଂ, ଅଟୋମୋଟିଭ୍ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ଡିଜିଟାଲ୍ ପରିବର୍ତନ ଦ୍ୱାରା ଚାଳିତ ଦୀର୍ଘକାଳୀନ ସେମିକଣ୍ଡକ୍ୱର ଚାହିଦା ଉପରେ ଦୃଢ଼ ଆତ୍ମବିଶ୍ୱାସକୁ ପ୍ରତିଫଳିତ କରେ । ଦେଶଗୁଡିକ ଉତ୍ପାଦନ କ୍ଷମତାକୁ ବିକ୍ଷାର କରିବା ଏବଂ ଉନ୍ନତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ନିବେଶ କରିବା ସହିତ, ଭାରତ ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକ୍ୱର ଯୋଗାଣ ଶୃଙ୍ଖଳରେ ଅଧିକ ଗଭୀର ଭାବରେ ସମନ୍ୱିତ ହେବାର ଏକ ଅନନ୍ୟ ସୁଯୋଗ ପାଇଛି । ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିଡିଓ ମୂଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ଡିଜାଇନ, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି । ଶିଳ୍ପ ବିଶେଷଜ୍ଞମାନେ ବିଶ୍ୱାସ କରନ୍ତି ଯେ ବିଶ୍ୱବ୍ୟାପୀ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ଉତ୍ପାଦନ ଭିଡିଓରେ ବୃଦ୍ଧି ପାଉଥିବା ନିବେଶ ଭାରତୀୟ କମ୍ପାନୀଗୁଡିକ ପାଇଁ ସେମିକଣ୍ଡକ୍ୱର ଡିଜାଇନ, ଉପକରଣ ଇଞ୍ଜିନିୟରିଂ, ସାମଗ୍ରୀ, ଉତ୍ପାଦନ ସେବା ଏବଂ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ସୁଯୋଗକୁ ଆହୁରି ଖୋଲିବ ।

Date	12th June
Publication	Manthan
Quote By	Ashok Chandak

ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ- ନେତୃତ୍ୱାଧୀନ ବୃଦ୍ଧିର ସଙ୍କୋଚ ଦେଉଛି; ଭାରତକୁ ପାଇଦା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ତ୍ୱେମାର୍ଷିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଡକ୍ୱର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେତରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି। ସେମିର ଖର୍ଚ୍ଚାଓଭାଉ ସେମିକଣ୍ଡକ୍ୱର ଉପକରଣ ବଜାର

ପରି ସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି। ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଟା କହିଛନ୍ତି, ‘୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ତାଳିତ ସେମିକଣ୍ଡକ୍ୱର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିତିଭୂମିରେ ନିରଂର ଶିକ୍ଷା ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି।

ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିତିଭୂମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଡକ୍ୱର ଡିଜାଇନ, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି।

Date	12th June
Publication	Orissa Times
Quote By	Ashok Chandak

Record Global Semiconductor Equipment Spending Signals Strong AI-Led Growth; India Poised to Benefit

Bhubaneswar : Global semiconductor equipment billings reached a record US\$36.55 billion in the first quarter of 2026, reflecting continued investments in semiconductor manufacturing capacity and technology upgrades worldwide. According to SEMI's Worldwide Semiconductor Equipment Market Statistics (WWSEMS) report, equipment billings grew 14% year-on-year, driven largely by accelerating demand from artificial intelligence (AI), advanced logic, DRAM memory, and advanced packaging technologies. Commenting on the report, Ajit Manocha, President and CEO of SEMI, said, "The strong start to 2026 reflects continued industry investment in the capacity and infrastructure needed to support AI-driven semiconductor growth. With the foundation being created through the India Semiconductor Mission and the expected next phase of policy support, India can emerge as a significant hub for semiconductor design, advanced packaging, manufacturing, supply chain and ecosystem development. Said, Ashok Chandak, President SEMI India and IESA.

Date	12th June
Publication	Pratigyan
Quote By	Ashok Chandak

ସୈନିକଶକ୍ତି ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ, ଏଆଇ-ନେତୃତ୍ୱାଧୀନ ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଉଛି, ଭାରତକୁ ଫାଇଦା ମିଳିପାରିବ

ନୂଆଦିଲ୍ଲୀ, ୧୧।୦୬(ପ୍ରତିଜ୍ଞା ନ୍ୟୁଜ୍): ବିଶ୍ୱ ସୈନିକଶକ୍ତିର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ଟ୍ରେନାସିକରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଞ୍ଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସୈନିକଶକ୍ତିର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସୈନିକ ଖର୍ଚ୍ଚକୁ ସୈନିକଶକ୍ତିର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି, ଯାହା ମୁଖ୍ୟତଃ କୃତ୍ରିମ ବୁଦ୍ଧିମତା (ଏଆଇ), ଉନ୍ନତ ଲଜିଷ୍ଟିକ୍ସ, ଡ୍ରାମା ମେମୋରା ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାକୁ ଚାହିଦାକୁ ଦୂରାନ୍ୱିତ କରି ପରିଚାଳିତ ହୋଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସୈନିକ ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋରା କହିଛନ୍ତି, “୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ ସୈନିକଶକ୍ତିର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିତ୍ତିଭୂମିରେ ନିରନ୍ତର ଶିଳ୍ପ ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ରେକର୍ଡ ପ୍ରଥମ ଟ୍ରେନାସିକ ବିଲିଂ ଅଗ୍ରଣୀ ଉତ୍ପାଦନ ଏବଂ ଉନ୍ନତ ପ୍ୟାକେଜିଂରେ ଚାଲୁଥିବା ଗତିକୁ ଉଜ୍ଜ୍ୱଳ କରିଛି ।” ରେକର୍ଡ ଖର୍ଚ୍ଚ ଦାର୍ଢ଼କାଳୀନ ସୈନିକଶକ୍ତିର ଚାହିଦା ପ୍ରତି ଶିଳ୍ପର ବିଶ୍ୱାସକୁ ଅଙ୍କିତ କରିଛି ଏବଂ ବିଶ୍ୱବ୍ୟାପୀ ଉତ୍ପାଦନ କ୍ଷମତାର ନିରନ୍ତର ପ୍ରସାରଣକୁ ସଙ୍କେତ ଦିଏ । ଖାସ୍ତା ଫେବ୍ରିକେସନ୍, ପ୍ୟାକେଜିଂ, ପରୀକ୍ଷଣ ଏବଂ ସୈନିକଶକ୍ତିର ଉପକରଣରେ ବର୍ଦ୍ଧିତ ନିବେଶ ଯୋଗାଣ ଶୁଖିଲକୁ ସୁଦୃଢ଼ କରିବ ଏବଂ ବିଶ୍ୱବ୍ୟାପୀ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ନବସୃଜନକୁ ଦୂରାନ୍ୱିତ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି । ଭାରତ ସୈନିକଶକ୍ତିର ଅଭିବୃଦ୍ଧିର ଏହି ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟରେ ଅଂଶଗ୍ରହଣ କରିବା ପାଇଁ ସକ୍ରିୟ ଭାବରେ ନିଜକୁ ସ୍ଥିତି ପ୍ରଦାନ କରୁଛି । ଭାରତ ସୈନିକଶକ୍ତିର ମିଶନ (ଆଇଏସଏମ) ଅଧୀନରେ, ସୈନିକଶକ୍ତିର ଫେବ୍ରିକେସନ୍, ଏଟିଏମପି/ଏସଏଟି, ପ୍ରଦର୍ଶନ ଉତ୍ପାଦନ ଏବଂ ଉପାଦାନ

ଇକୋସିଷ୍ଟମରେ ୧୨ଟି ସୈନିକଶକ୍ତିର ଏବଂ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନ ପ୍ରକଳ୍ପକୁ ଅନୁମୋଦନ କରାଯାଇଛି । ପ୍ରତ୍ୟକ୍ଷିତ ଆଇଏସଏମ ୨.୦ କାର୍ଯ୍ୟକ୍ରମ ସୈନିକଶକ୍ତିର ଉତ୍ପାଦନ, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ସାମଗ୍ରୀ, ଉପକରଣ ଏବଂ ଡିଜାଇନ୍ କ୍ଷେତ୍ରରେ ଭାରତର କ୍ଷମତାକୁ ଆହୁରି ସୁଦୃଢ଼ କରିବ ବୋଲି ଆଶା କରାଯାଉଛି, ଯାହା ଦେଶକୁ ବର୍ଦ୍ଧିତ ବିଶ୍ୱ ସୈନିକଶକ୍ତିର ମୂଲ୍ୟ ଶୁଖିଲର ଏକ ବୃହତ ଅଂଶ ଦଖଲ କରିବାରେ ସାହାଯ୍ୟ କରିବ । “ବିଶ୍ୱବ୍ୟାପୀ ରେକର୍ଡ ପରିମାଣର ସୈନିକଶକ୍ତିର ଉପକରଣ ଖର୍ଚ୍ଚ ଲଓ, ଉଚ୍ଚ-ପ୍ରଦର୍ଶିତ କମ୍ପ୍ୟୁଟିଂ, ଅଟୋମୋଟିଭ୍ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଏବଂ ଡିଜିଟାଲ ପରିବର୍ତ୍ତନ ଦ୍ୱାରା ଚାଳିତ ଦାର୍ଢ଼କାଳୀନ ସୈନିକଶକ୍ତିର ଚାହିଦା ଉପରେ ଦୃଢ଼ ଆତ୍ମବିଶ୍ୱାସକୁ ପ୍ରତିଫଳିତ କରେ । ଦେଶଗୁଡ଼ିକ ଉତ୍ପାଦନ କ୍ଷମତାକୁ ବିସ୍ତାର କରିବା ଏବଂ ଉନ୍ନତ ପ୍ରଯୁକ୍ତିବିଦ୍ୟାରେ ନିବେଶ କରିବା ସହିତ, ଭାରତ ବିଶ୍ୱବ୍ୟାପୀ ସୈନିକଶକ୍ତିର ଯୋଗାଣ ଶୁଖିଲରେ ଅଧିକ ଗଭୀର ଭାବରେ ସମନ୍ୱିତ ହେବାର ଏକ ଅନନ୍ୟ ସୁଯୋଗ ପାଇଛି । ଭାରତ ସୈନିକଶକ୍ତିର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମୂଳରେ ଭିତ୍ତିଭୂମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସୈନିକଶକ୍ତିର ଡିଜାଇନ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୁଖିଲ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚନ୍ଦକ, ସଭାପତି ସୈନିକଶକ୍ତି ଏବଂ ଆଇଆଇଏସଏ କହିଛନ୍ତି । ଶିଳ୍ପ ବିଶେଷଜ୍ଞମାନେ ବିଶ୍ୱାସ କରନ୍ତି ଯେ ବିଶ୍ୱବ୍ୟାପୀ ଉନ୍ନତ ପ୍ୟାକେଜିଂ ଏବଂ ଉତ୍ପାଦନ ଭିତ୍ତିଭୂମିରେ ବୃଦ୍ଧି ପାଇଥିବା ନିବେଶ ଭାରତୀୟ କମ୍ପାନୀଗୁଡ଼ିକ ପାଇଁ ସୈନିକଶକ୍ତିର ଡିଜାଇନ୍, ଉପକରଣ ଇଞ୍ଜିନିୟରିଂ, ସାମଗ୍ରୀ, ଉତ୍ପାଦନ ସେବା ଏବଂ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ଉତ୍ପାଦନରେ ସୁଯୋଗକୁ ଆହୁରି ଖୋଲିବ ।

Date	12th June
Publication	Sakala
Quote By	Ashok Chandak

ସେମିକଣ୍ଠକୂର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ୍, ଏଆଇ-ନେତୃତ୍ୱାଧୀନ ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଉଛି; ଭାରତକୁ ଫାଇଦା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଠକୂର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ଟ୍ରେମାସିକରେ ରେକର୍ଡ୍ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଠକୂର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିର ଡ୍ୱାର୍ଲିଂଘାଇଡ୍ ସେମିକଣ୍ଠକୂର ଉପକରଣ ବଜାର ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିର ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋତା କହିଛନ୍ତି, ‘୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାଳିତ

ସେମିକଣ୍ଠକୂର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିତିଭୂମିରେ ନିରଂର ଶିକ୍ଷା ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ ସେମିକଣ୍ଠକୂର ମିଶନ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିତିଭୂମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଠକୂର ଡିଜାଇନ୍, ଉନ୍ନତ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ଗୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏସଏ କହିଛନ୍ତି ।

Date	12th June
Publication	Azad Sipahi
Quote By	Ashok Chandak

सेमीकंडक्टर इक्विपमेंट पर रिकॉर्ड ग्लोबल खर्च एआइ-आधारित मजबूत ग्रोथ का संकेत, भारत को फायदा मिलेगा

आजाद सिपाही संवाददाता
भुवनेश्वर। 2026 की पहली तिमाही में ग्लोबल सेमीकंडक्टर इक्विपमेंट की बिक्री (बिलिंग) रिकॉर्ड यूएस\$36.55 बिलियन तक पहुंच गयी, जो दुनिया भर में सेमीकंडक्टर मैन्युफैक्चरिंग क्षमता और टेक्नोलॉजी अपग्रेड में लगातार निवेश को दिखाती है। रपटकी 'वर्ल्डवाइड सेमीकंडक्टर इक्विपमेंट मार्केट स्टैटिस्टिक्स' रिपोर्ट के अनुसार, इक्विपमेंट की

बिक्री में साल-दर-साल 14% की बढ़ोतरी हुई। इसकी मुख्य वजह आर्टिफिशियल इंटेलिजेंस (एआइ), एडवांस्ड लॉजिक, डीआरएम मेमोरी और एडवांस्ड पैकेजिंग टेक्नोलॉजी की तेजी से बढ़ती मांग थी। रिपोर्ट पर टिप्पणी करते हुए रसेमी के प्रेसिडेंट और सीइओ अजीत मनोचा ने कहा कि 2026 की मजबूत शुरूआत यह दिखाती है कि इंडस्ट्री एआइ-आधारित सेमीकंडक्टर ग्रोथ को

सपोर्ट करने के लिए जरूरी क्षमता और इंफ्रास्ट्रक्चर में लगातार निवेश कर रही है। पहली तिमाही की रिकॉर्ड बिक्री अत्याधुनिक मैन्युफैक्चरिंग और एडवांस्ड पैकेजिंग में जारी तेजी को उजागर करती है। रिकॉर्ड खर्च सेमीकंडक्टर की लंबी अवधि की मांग में इंडस्ट्री के भरोसे को दिखाता है और ग्लोबल मैन्युफैक्चरिंग क्षमता के लगातार विस्तार का संकेत देता है। वेफर

फैब्रिकेशन, पैकेजिंग, टेस्टिंग और सेमीकंडक्टर इक्विपमेंट में बढ़े हुए निवेश से सप्लाय चैन मजबूत होने और दुनिया भर में टेक्नोलॉजी इनोवेशन में तेजी आने की उम्मीद है। भारत सेमीकंडक्टर ग्रोथ के इस अगले चरण में शामिल होने के लिए सक्रिय रूप से खुद को तैयार कर रहा है। 'इंडिया सेमीकंडक्टर मिशन' के तहत, 12 सेमीकंडक्टर और इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग प्रोजेक्ट्स को मंजूरी दी गयी है।

Date	12th June
Publication	Utkal Samaja
Quote By	Ashok Chandak

ସେମିକଣ୍ଠକୂଳ ଉପକରଣ ବିକାଶ
 ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ,
 ଏଆଇ-ନେଚୁରାଧୀନ ବୃଦ୍ଧିର
 ସଙ୍କେତ ଦେଖି; ଭାରତକୁ
 ପାଇବା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସେମିକଣ୍ଠକୂଳ ଉପକରଣ ବିକାଶ ୨୦୨୬ ର ପ୍ରଥମ ଡ୍ରେମାସ୍କେଚରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସେମିକଣ୍ଠକୂଳ ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରେଡରେ ନିରବର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସେମିକ ବିଶ୍ୱାସନୀୟ ସେମିକଣ୍ଠକୂଳ ଉପକରଣ ବଜାର ପରିବ୍ୟାପୀନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିକାଶ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସେମିକ ସଭାପତି ଏବଂ ସିଇଓ ଅଜିତ ମନୋଜା କହିଛନ୍ତି, '୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଡାଟିଓ ସେମିକଣ୍ଠକୂଳ ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିତ୍ତିଭୂମିରେ ନିରା ଶିଳ୍ପ ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ ସେମିକଣ୍ଠକୂଳ ନିଶ୍ଚଳ ଏବଂ ଆଶା କରାଯାଉଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିତ୍ତିଭୂମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସେମିକଣ୍ଠକୂଳ ଡିଜାଇନ୍, ଉତ୍ପାଦ ପ୍ୟାକେଜିଂ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇଲେକ୍ଟ୍ରୋନିକ୍ସ ବିକାଶ ପାଇଁ ଏକ ସ୍ତୁରପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚଣ୍ଡକ, ସଭାପତି ସେମି ଇଣ୍ଡିଆ ଏବଂ ଆଇଭଏସଏ କହିଛନ୍ତି ।

Date	12th June
Publication	Swatantra Barta
Quote By	Ashok Chandak

ସୈନିକଶକ୍ତିର ଉପକରଣ ଖର୍ଚ୍ଚ ଉପରେ ବିଶ୍ୱ ରେକର୍ଡ ଏଆଇ-ନେତୃତ୍ୱାଧୀନ ବୃଦ୍ଧିର ସଙ୍କେତ ଦେଖନ୍ତୁ; ଭାରତକୁ ପାଇବା ମିଳିପାରିବ

ଭୁବନେଶ୍ୱର : ବିଶ୍ୱ ସୈନିକଶକ୍ତିର ଉପକରଣ ବିଲିଂ ୨୦୨୬ ର ପ୍ରଥମ ଚୂନାବଳୀରେ ରେକର୍ଡ ୩୬.୫୫ ବିଲିୟନ ଆମେରିକୀୟ ଡଲାରରେ ପହଂଚିଛି, ଯାହା ବିଶ୍ୱବ୍ୟାପୀ ସୈନିକଶକ୍ତିର ଉତ୍ପାଦନ କ୍ଷମତା ଏବଂ ପ୍ରଯୁକ୍ତିବିଦ୍ୟା ଅପଗ୍ରହରେ ନିରନ୍ତର ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ସୈନିକ ବ୍ୟୟର ଉତ୍ପାଦନ ସୂଚକ

ପରିସଂଖ୍ୟାନ ରିପୋର୍ଟ ଅନୁଯାୟୀ, ଉପକରଣ ବିଲିଂ ବର୍ଷ ବର୍ଷ ଧରି ୧୪% ବୃଦ୍ଧି ପାଇଛି । ରିପୋର୍ଟ ଉପରେ ମତାମତ ଦେଇ, ସୈନିକ ସମ୍ପାଦକ ଏବଂ ସିଇଓ ଅଜିତ ମନୋଜା କହିଛନ୍ତି, '୨୦୨୬ ର ଦୃଢ଼ ଆରମ୍ଭ ଏଆଇ-ଚାରିଟ ସୈନିକଶକ୍ତିର ଅଭିବୃଦ୍ଧିକୁ ସମର୍ଥନ କରିବା ପାଇଁ ଆବଶ୍ୟକ କ୍ଷମତା ଏବଂ ଭିତ୍ତିଭୂମିରେ ନିରନ୍ତର ଶିଳ୍ପ ନିବେଶକୁ ପ୍ରତିଫଳିତ କରୁଛି । ଭାରତ

ସୈନିକଶକ୍ତିର ମିଶନ ଏବଂ ଆଶା କରାଯାଇଥିବା ପରବର୍ତ୍ତୀ ପର୍ଯ୍ୟାୟ ନୀତି ସମର୍ଥନ ମାଧ୍ୟମରେ ଭିତ୍ତିଭୂମି ସୃଷ୍ଟି ହେବା ସହିତ, ଭାରତ ସୈନିକଶକ୍ତିର ଡିଜାଇନ, ଉତ୍ପାଦନ, ଉତ୍ପାଦନ, ଯୋଗାଣ ଶୃଙ୍ଖଳ ଏବଂ ଇକୋସିଷ୍ଟମ୍ ବିକାଶ ପାଇଁ ଏକ ପୁରୁତ୍ୱପୂର୍ଣ୍ଣ କେନ୍ଦ୍ର ଭାବରେ ଉଭା ହୋଇପାରିବ ବୋଲି ଅଶୋକ ଚନ୍ଦକ, ସମ୍ପାଦକ ସୈନିକ ଇଣ୍ଡିଆ ଏବଂ ଆଇଇଏଏଏ କହିଛନ୍ତି ।

**Quote - Record Global Semiconductor Equipment
PRNT GUJARAT**

Date	1th June
Publication	Divya Gujarat
Quote By	Ashok Chandak

વૈશ્વિક સેમિકન્ડક્ટર સાધનો પર ખર્ચનો રેકોર્ડ, AI આધારિત વૃદ્ધિને મજબૂત સંકેત; ભારતને મોટો લાભ મળવાની સંભાવના

૨૦૨૬ ના પ્રથમ ત્રિમાસિક ગાળામાં વૈશ્વિક સેમિકન્ડક્ટર સાધનો પર ખર્ચ રેકોર્ડ US\$36.55 અબજ સુધી પહોંચ્યો છે, જે વિશ્વભરમાં સેમિકન્ડક્ટર મેન્યુફેક્ચરિંગ ક્ષમતા અને ટેકનોલોજી અપગ્રેડમાં ચાલુ રોકાણોને દર્શાવે છે. SEMI ની Worldwide Semiconductor Equipment Market Statistics (WWSEMS) રિપોર્ટ

મુજબ, સાધનો પર ખર્ચમાં વર્ષ-દર-વર્ષ ૧૪% નો વધારો નોંધાયો છે, જે મુખ્યત્વે આર્ટિફિશિયલ ઇન્ટેલિજન્સ (AI), એડવાન્સ લોજિક, DRAM મેમરી અને એડવાન્સડ પેકેજિંગ ટેકનોલોજીની વધતી માંગને કારણે થયો છે.

આ રિપોર્ટ અંગે પ્રતિભાવ આપતા SEMI ના પ્રમુખ અને CEO અજીત મનોયાએ જણાવ્યું કે,

“૨૦૨૬ ની મજબૂત શરૂઆત એ દર્શાવે છે કે AI આધારિત સેમિકન્ડક્ટર વૃદ્ધિને સમર્થન આપવા માટે ઉદ્યોગમાં ક્ષમતા અને ઇન્ફ્રાસ્ટ્રક્ચરમાં સતત રોકાણ થઈ રહ્યું છે. પ્રથમ ત્રિમાસિકના રેકોર્ડ બિલિંગ્સ એ લીડિંગ-એજ મેન્યુફેક્ચરિંગ અને એડવાન્સડ પેકેજિંગમાં ચાલતી ગતિને ઉજાગર કરે છે.”

Date	1th June
Publication	Gujarat Pranam
Quote By	Ashok Chandak

વૈશ્વિક સેમિકન્ડક્ટર સાધનો પર ખર્ચનો રેકોર્ડ, AI આધારિત વૃદ્ધિને મજબૂત સંકેત; ભારતને મોટો લાભ મળવાની સંભાવના

નવી દિલ્હી, ભારત – ૨૦૨૬ ના પ્રથમ ત્રિમાસિક ગાળામાં વૈશ્વિક સેમિકન્ડક્ટર સાધનો પર ખર્ચ રેકોર્ડ **US\$૩૬.૫૫** અબજ સુધી પહોંચ્યો છે, જે વિશ્વભરમાં સેમિકન્ડક્ટર મેન્યુફેક્ચરિંગ ક્ષમતા અને ટેકનોલોજી અપગ્રેડમાં ચાલુ રોકાણોને દર્શાવે છે. **SEMI™e Worldwide Semiconductor Equipment Market Statistics (WWSEMS)** રિપોર્ટ મુજબ, સાધનો પર ખર્ચમાં વર્ષ-દર-વર્ષ ૧૪% નો વધારો નોંધાયો છે, જે મુખ્યત્વે આર્ટિફિશિયલ ઇન્ટેલિજન્સ (AI), એડવાન્સડ લોજિક, **DRAM** મેમરી અને એડવાન્સડ પેકેજિંગ ટેકનોલોજીની વધતી માંગને કારણે થયો છે.

આ રિપોર્ટ અંગે પ્રતિભાવ આપતા **SEMI** ના પ્રમુખ અને **CEO** અજીત

મનોચાએ જણાવ્યું કે, “૨૦૨૬ ની મજબૂત શરૂઆત એ દર્શાવે છે કે છેલ્લા આધારિત સેમિકન્ડક્ટર વૃદ્ધિને સમર્થન આપવા માટે ઉદ્યોગમાં ક્ષમતા અને ઇન્ફ્રાસ્ટ્રક્ચરમાં સતત રોકાણ થઈ રહ્યું છે. પ્રથમ ત્રિમાસિકના રેકોર્ડ બિલિંગ્સ એ લીડિંગ-એજ મેન્યુફેક્ચરિંગ અને એડવાન્સડ પેકેજિંગમાં ચાલતી ગતિને ઉજાગર કરે છે.”

આ રેકોર્ડ ખર્ચ ઉદ્યોગના લાંબા ગાળાના સેમિકન્ડક્ટર માંગ પર વિશ્વાસને મજબૂત બનાવે છે અને વૈશ્વિક મેન્યુફેક્ચરિંગ ક્ષમતાના વિસ્તરણનો સંકેત આપે છે. વેફર ફેબ્રિકેશન, પેકેજિંગ, ટેસ્ટિંગ અને સેમિકન્ડક્ટર સાધનોમાં વધતા રોકાણો સપ્લાય ચેઇનને મજબૂત બનાવશે અને ટેકનોલોજી નવીનતાને વધુ ઝડપ આપશે.

**EXCLUSIVE INTERVIEW
ONLINE**

Date	1th June
Publication	ANI
Link	https://aninews.in/news/business/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153720/



Navin Bishnoi, Chairperson of the India Electronics and Semiconductor Association (IESA) (Photo/ANI)

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ANI | Updated: Jun 11, 2026 15:37 IST



By Kaushal Verma

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**ANI PICKUPS - INDUSTRY STROY
ONLINE**

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Publication	Telangana Journal
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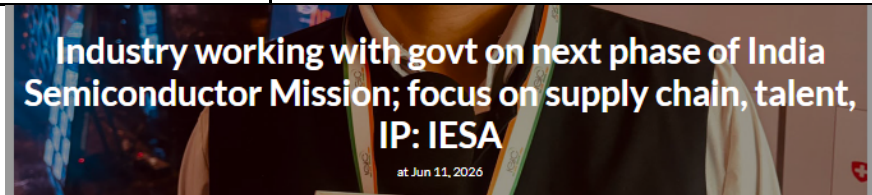
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Publication	Karnataka Live
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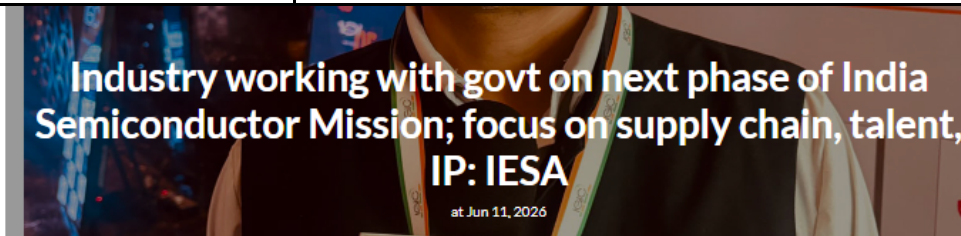
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Publication	Kashmir Newsline
Link	https://www.kashmirnewsline.in/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/



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Publication	Rajasthan Ki khabar
Link	https://www.rajsthankikhabar.com/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/



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Date	1th June
Publication	Gujarat Varta
Link	https://www.irmplsarvices.com/redir.php?id=225710630

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Publication	Andhra Pradesh Mirror
Link	https://www.irmplsolutions.com/redirect.php?id=225709878

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Date	1th June
Publication	Indian News Network
Link	https://www.indiannewsnetwork.net/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesas20260611153715/

Industry working with govt on next phase of India Semiconductor Mission; focus on supply chain, talent, IP: IESA

Jun 11, 2026

By Kaushal Verma

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Bishnoi said another key challenge is ensuring that the sector remains sustainable beyond government incentives. He noted that long-term success would depend on creating a viable buyer-seller market and a commercialisation ecosystem capable of supporting sustained growth.

Date	1th June
Publication	Maharashtra Samachar
Link	https://www.maharashtrasamachar.com/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/

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Date	1th June
Publication	Bihar 24x7
Link	https://www.bihar24x7.com/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/

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Publication	South India News
Link	https://www.southindianews.in/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/

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Date	1th June
Publication	North East Times
Link	https://www.northeasttimes.in/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/

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Date	1th June
Publication	Chhattisgarh Today
Link	https://www.chhattisgarhtoday.in/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/

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Publication	Haryana Today
Link	https://www.haryanatoday.in/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/

TODAY
Tue, Jun 30, 2026 | Updated 11:04 IST

HOME NATIONAL BUSINESS WORLD SPORTS ENTERTAINMENT



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Date	1th June
Publication	Vanakkam Tamil Nadu
Link	https://www.vanakkamtamilnadu.com/news/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa20260611153715/



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Jun 30, 2026



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Date	1th June
Publication	Kolkata Sun
Link	https://www.kolkatasun.com/news/279116468/industry-working-with-govt-on-next-phase-of-india-semiconductor-mission-focus-on-supply-chain-talent-ip-iesa

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ANI
11 Jun 2026, 17:32 GMT+10



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**QUOTE - REPORT
ONLINE**

Date	1th June
Publication	AEI Japan
Link	https://aei.dempa.net/archives/35247

India Targets to Grow from Chip Equipment Boom

India is set to strengthen its position in the global semiconductor value chain as worldwide spending on chipmaking equipment reaches unprecedented levels, driven by artificial intelligence (AI) and advanced technology demand.

This as global semiconductor equipment billings climbed to a record US\$36.55 billion in the first quarter of 2026, marking a 14% year-on-year increase, according to SEMI's Worldwide Semiconductor Equipment Market Statistics (WWSEMS) report.

AI Drives Record Equipment Investments

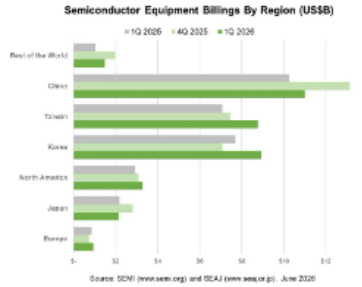


Fig. 1: Semiconductor Equipment Billings by Region in US\$ billion (Source: SEMI and SEAJ, June 2026)

The record spending is being fueled largely by accelerating demand from AI, high-performance computing, and advanced semiconductor applications. Investments in leading-edge logic, DRAM memory, and advanced packaging technologies are reshaping manufacturing priorities globally.

Ajit Manocha, President and CEO of SEMI, said the strong start to 2026 underscores sustained industry investment in capacity and infrastructure to support AI-driven growth. He noted that record billings signal continued momentum in leading-edge manufacturing and advanced packaging.

This wave of investment is also expanding global manufacturing capacity and strengthening semiconductor supply chains, with increased spending across wafer fabrication, packaging, testing, and equipment.

"The strong start to 2026 reflects continued industry investment in the capacity and infrastructure needed to support AI-driven semiconductor growth. Record first-quarter billings highlight ongoing momentum in leading-edge manufacturing and advanced packaging."

Semiconductor Equipment Market Revenue by Region

Region	1Q 2026	4Q 2025	1Q 2025	1Q (QoQ)	1Q (YoY)
Europe	\$0.65	\$0.74	\$0.67	28%	0%
Japan	\$2.16	\$2.82	\$2.18	-24%	-1%
North America	\$3.28	\$3.09	\$2.93	6%	12%
Korea	\$8.93	\$7.08	\$7.09	26%	16%
Taiwan	\$8.77	\$7.44	\$7.09	18%	24%
China	\$10.99	\$13.13	\$10.28	-18%	7%
Rest of the World	\$1.48	\$1.07	\$1.03	-25%	45%
Total	\$36.55	\$36.27	\$32.05	1%	14%

Sources: SEMI (www.semi.org) and SEAJ (www.seaj.or.jp), June 2026
Note: Summed subtotals may not equal the total due to rounding.

Fig. 2: Semiconductor Equipment Market Revenue by Region in US\$ billion (Source: SEMI and SEAJ)

Supply Chain Expansion Opens Doors for India

Industry leaders believe the expansion of semiconductor infrastructure worldwide will unlock new opportunities for Indian companies across multiple segments. These include semiconductor design, manufacturing services, materials, and equipment engineering.

Ashok Chandak, President of SEMI India and IESA, emphasized that rising global investments reflect confidence in long-term demand driven by AI, automotive electronics, and digital transformation. He highlighted India's potential to integrate more deeply into global supply chains as countries scale up manufacturing and adopt advanced technologies.

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"The record global semiconductor equipment spending reflects strong confidence in long-term semiconductor demand driven by AI, high-performance computing, automotive electronics, and digital transformation. As countries expand manufacturing capacity and invest in advanced technologies, India has a unique opportunity to integrate more deeply into global semiconductor supply chains," said Chandak.



Ashok Chandak, President of SEMI India and IESA

"With the foundation being created through the India Semiconductor Mission and the expected next phase of policy support, India can emerge as a significant hub for semiconductor design, advanced packaging, manufacturing, supply chain and ecosystem development."

With policy support and ecosystem development underway, India could emerge as a key hub for semiconductor design, advanced packaging, and manufacturing. The convergence of global investment trends and domestic initiatives places the country in a strong position to benefit from the next phase of semiconductor industry growth.

India's Opportunity in a Growing Global Market

The surge in capital expenditure reflects rising investments in semiconductor manufacturing capacity and next-generation technologies. For India, this momentum presents a strategic opportunity to deepen its role in global supply chains.

Through the India Semiconductor Mission (ISM), the country has already approved 12 semiconductor and electronics manufacturing projects spanning fabrication, assembly, testing, display manufacturing, and components. These initiatives are laying the groundwork for India to capture a larger share of the semiconductor ecosystem.

The anticipated expansion of the program under ISM 2.0 is expected to further boost capabilities across manufacturing, advanced packaging, materials, equipment, and chip design. This policy push could enable India to move beyond assembly into higher-value segments of the semiconductor value chain.

12 June 2026

**ONLINE
INDUSTRY STORY**

Date	10th June
Publication	DQ India
Link	https://www.dqindia.com/semiconductors/karnataka-government-provides-details-of-esdm-policies-12022406

Karnataka Government provides details of ESDM policies

Karnataka ESDM policy matters to all. It gives startups and MSMEs strong support through financial incentives, grants, subsidies, and incubation opportunities

Pradeep Chakraborty

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India Electronics & Semiconductor Association (IESA) organized a seminar today on the Karnataka Government ESDM policies.



Pramod L. Patil, KAS, GM, Karnataka Innovation and Technology Society (KITS), presented details about the policy. We are looking at different policies. We have about 8-10 policies. Now, we have an ESDM policy.

Karnataka ESDM policy

Karnataka ESDM policy matters to all of us. It gives startups and MSMEs strong support through financial incentives, grants, subsidies, and incubation opportunities--helping innovative ideas grow into successful ventures. It expands access to tech hubs, CoE, TBIs, and incubators, empowering students, entrepreneurs, and young innovators. It creates more local jobs in high-tech electronics, chip design and manufacturing, improving opportunities for people across the state.

ONLINE

Quote -Report Worldwide Semiconductor Equipment Market Statistics

Date	10th June
Publication	ET Manufacturing
Link	https://manufacturing.economictimes.indiatimes.com/news/india-poised-to-gain-from-semiconductor-boom-as-global-billings-hit-record-36-6-billion-in-q1-report/131627395

India poised to gain from semiconductor boom as global billings hit record \$36.6 billion in Q1: Report

SEMI says India's expanding semiconductor ecosystem, backed by government incentives, could help the country emerge as a key hub for semiconductor manufacturing and supply chain development.

ETManufacturing

Published On Jun 10, 2026 at 12:07 PM IST



According to the report, China led global semiconductor equipment billings with over \$10 billion in Q1 2026, followed by South Korea and Taiwan.

India is expected to benefit from strong global demand for semiconductors as global semiconductor equipment billings hit a record \$36.55 billion in Q1 2026, noted SEMI's Worldwide Semiconductor Equipment Market Statistics (W\SEM\SEM\SEM) report on Wednesday.

“The strong start to 2026 reflects continued industry investment in the capacity and infrastructure needed to support AI-driven semiconductor growth. Record first-quarter billings highlight ongoing momentum in leading-edge manufacturing and advanced packaging,” Ajit Manocha, President and CEO of SEMI.

India is actively positioning itself to participate in this next phase of semiconductor growth. Under the [India Semiconductor Mission \(ISM\)](#), 12 semiconductor and electronics manufacturing projects have been approved across semiconductor fabrication, ATMP/OSAT, display manufacturing, and component ecosystems.

The anticipated ISM 2.0 program is expected to further strengthen India's capabilities in semiconductor manufacturing, advanced packaging, materials, equipment, and design, helping the country capture a larger share of the growing global semiconductor value chain, the report noted.

According to the report, China led global semiconductor equipment billings with over \$10 billion in Q1 2026, followed by South Korea and Taiwan.

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“India has a unique opportunity to integrate more deeply into global semiconductor supply chains. With the foundation being created through the India Semiconductor Mission and the expected next phase of policy support, India can emerge as a significant hub for semiconductor design, advanced packaging, manufacturing, supply chain and ecosystem development,” said Ashok Chandak, President SEMI India and IESA.

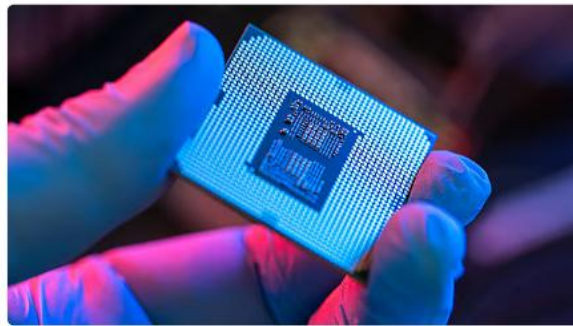
Date	10th June
Publication	Forbes
Link	https://www.fortuneindia.com/technology/global-semiconductor-equipment-spending-hits-record-3655-billion-in-q1-2026-india-eyes-larger-role-in-supply-chain/142322

Global semiconductor equipment spending hits record \$36.55 billion in Q1 2026; India eyes larger role in supply chain

Subhojit Sarkar
June 10, 2026, 10:44 IST / 2 min read



The growth was driven by strong demand from AI-related applications, advanced logic chips, DRAM memory, and advanced packaging technologies.



The record spending reflects the industry's confidence in long-term semiconductor demand and points to continued expansion of global manufacturing capacity. Credit: Getty Images



Global semiconductor equipment billings reached a record \$36.55 billion in the first quarter of 2026, underscoring sustained investments in chip manufacturing capacity and technology upgrades amid growing demand for artificial intelligence (AI) and advanced computing applications.

According to SEMI's Worldwide Semiconductor Equipment Market Statistics (WWSEMS) report, semiconductor equipment billings rose 14% year-on-year during the quarter. The growth was driven by strong demand from AI-related applications, advanced logic chips, DRAM memory, and advanced packaging technologies.



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"The strong start to 2026 reflects continued industry investment in the capacity and infrastructure needed to support AI-driven semiconductor growth. Record first-quarter billings highlight ongoing momentum in leading-edge manufacturing and advanced packaging," said Ajit Manocha, President and CEO of SEMI.

The record spending reflects the industry's confidence in long-term semiconductor demand and points to continued expansion of global manufacturing capacity. Investment across wafer fabrication, packaging, testing, and semiconductor equipment are expected to strengthen supply chains and accelerate technological innovation worldwide.

AI HUB ×

- Summary
- Key Takeaways
- FAQs

ONLINE
QUOTE - INDUSTRY STORY

Date	10th June
Publication	Economic Times
Link	https://economictimes.indiatimes.com/tech/technology/sez-import-relief-to-fast-track-chip-projects/articleshow/131614141.cms

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Business News > Tech > Tech & Internet > SEZ import relief to fast track chip projects

ETPrime

SEZ import relief to fast track chip projects

By Suraksha P, ETtech • Last Updated: Jun 10, 2026, 06:00:00 AM IST


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Synopsis
 India's semiconductor manufacturing sector is set for a major boost. New rules exempt imports for Special Economic Zones from quality checks. This will speed up the setup of chip fabrication plants and assembly units. Companies can now import necessary equipment and materials without delays. Compliance with Indian standards will only be required when products enter the domestic market.



Date	10th June
Publication	MSN
Link	https://www.msn.com/en-in/news/india/sez-import-relief-to-fast-track-chip-projects/ar-AA25dYc0

SEZ import relief to fast-track chip projects

Story by Suraksha P • 2w •  3 min read



[SEZ import relief to fast track chip projects](#)

The Centre's decision to exempt all permissible imports by Special Economic Zone (SEZ) units and developers from Quality Control Orders (QCOs) and mandatory Bureau of Indian Standards (BIS) requirements is expected to significantly accelerate semiconductor manufacturing projects being set up under the India Semiconductor Mission (ISM), analysts told ET.



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A notification was issued by the Directorate General of Foreign Trade (DGFT) on June 1, amending the Foreign Trade Policy to expand QCO exemptions for SEZ imports.

Previously, exemptions were limited to inputs required for export production. Under the revised rules, SEZ units and developers can import all permissible goods, including raw materials, components, consumables, spares and capital equipment, for authorised operations without having to comply with QCO requirements at the import stage.

However, any goods cleared from the SEZ into the Domestic Tariff Area (DTA) will need to comply with applicable QCOs and BIS requirements at the time of sale in the Indian market.

Analysts said the amendment addresses a longstanding concern for semiconductor manufacturers, whose facilities depend heavily on imported machinery, specialty chemicals and materials sourced from a limited pool of global suppliers.

**ONLINE
INDUSTRY STORY**

Date	4th June
Publication	The Hindu Business Line
Link	https://www.thehindubusinessline.com/info-tech/nvidias-ai-pc-push-may-open-opportunities-for-indias-semicon-ecosystem/article71062038.ece

NVIDIA's AI PC push may open opportunities for India's semicon ecosystem

While Intel and AMD have added AI capabilities to chips, NVIDIA has designed its chip from the ground up with AI at the core

By Sanjana B
Updated - June 04, 2023 at 09:26 PM



NVIDIA is seeking to reshape the PC industry with an AI-first chip architecture, a shift that experts say could strengthen India's role in the global AI and semiconductor value chain.

The chipmaker giant, on Monday, unveiled the RTX Spark, a new superchip that "reinvents Windows PCs for the era of personal AI agents".

"The PC is being reinvented," said Jensen Huang, founder and CEO of NVIDIA, describing RTX Spark as a platform built for local AI agents, creative workflows, and gaming. MediaTek, a market leader in Arm-based system-on-a-chip designs, collaborated with NVIDIA on the custom CPU design.

"For many years, Intel and AMD have dominated their markets. Meanwhile, NVIDIA has transformed the AI industry in five years. Huang's claim that NVIDIA is reinventing the PC triggered a sell-off across leading PC chip stocks, with the industry working to understand the larger implications," said Omprakash Subbarao, CEO of CORE Labs, FSIID.

While Intel and AMD have largely added AI capabilities to their usual chips, NVIDIA has designed its chip from the ground up with AI at the core, equipping it with substantial memory to enable large AI models to run directly on the laptop rather than depending on the internet, explained Prof. Sanket Goel, Chair Professor, BITS Pilani, and Head of CREST. In essence, NVIDIA is building its chip around the AI engine, treating it as the heart of the machine.

To date, most Windows laptops run on Intel or AMD chips. NVIDIA now gives the laptop makers a third choice. The RTX Spark will be included in a new line of Windows PCs made by Lenovo, HP, Dell, Microsoft Surface, Asus, and MSI. Models from Acer and Gigabyte to follow.

Ashok Chandak, President of IESA and SEMI India, argued that while Intel and AMD will continue to dominate mainstream PCs, NVIDIA is well-positioned in premium AI PCs by leveraging its strengths in AI software, GPUs, and accelerated computing. The move may not disrupt the market overnight, but it will intensify competition in AI-enabled computing.

Moreover, the increasing demand for AI-enabled computing is expected to drive the need for hardware platforms that deliver superior performance and greater energy efficiency.



**ONLINE
INDUSTRY STORY**

Date	1st June
Publication	The Times Of India
Link	https://timesofindia.indiatimes.com/city/chennai/focus-on-design-packaging-over-wafer-race-niti-aayog/articleshow/131427264.cms

Focus on design, packaging over wafer race: NITI Aayog

Vaitheswaran B / Jun 01, 2026, 04:00 IST

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Chennai: India should focus on its current strengths and aim for global leadership on design, outsourced semiconductor assembly and testing (OSAT), advanced packaging, and critical semiconductor materials, including wide bandgap and advanced packaging materials, rather than chasing the wafer race, according to a [NITI Aayog](#) report released on Friday.

The report argued that it should prioritise capital allocation and talent based on strategic importance and global value chain integration, contrasting with the gov't rhetoric and stated goal of ISM 2.0, announced in February, which included a roadmap for advanced manufacturing of 3 and 2 nanometre technology nodes.

NITI Aayog recommends pivoting away from continuing the catch-up game in the foundry race and focusing on advanced packaging, system integration and manufacturing scale, which matter as much as transistor nodes in the current era. It added that the country should be pragmatic and selective in advanced technology nodes. Mature-node logic, speciality analogue and mixed-signal chips and compound semiconductors such as Silicon Carbide (SiC) and Gallium Nitride (GaN), which power India's industrial and strategic sectors, matter most to India's economy, it said.

Raja Manickam, founder of iVP Semi, said India should focus on well-defined, high-value, mature foundational semiconductor products rather than cutting-edge products.

"Power semiconductors, simple logic, and catalogue chips are easier to design and manufacture, have strong existing demand, and can be produced in fabs with a comparatively lower capex, with roughly \$400-\$500 million. Foundational chips can generate large volumes, which helps India learn manufacturing at scale and attracts the supporting ecosystem, such as equipment makers, chemicals, materials suppliers, etc.," he said, adding, "Treat advanced node goals as longer-term after foundational capacity is established and use incentives strategically to develop domestic, non-Chinese equipment ecosystems in the country, he added.

Ashok Chandak, president of IESA and SEMI India, said India should focus on areas where it can compete today while continuing to invest in future capabilities. While design, packaging and mature-node segments can deliver near-term global relevance, he said India should avoid creating an artificial distinction between mature nodes and advanced technologies, as a successful semiconductor ecosystem requires both. Countries leading in advanced-node manufacturing have built their capabilities over decades, and India must continue investing in R&D, process technologies, pilot lines and future-node readiness, he added.

The report argues that India should target \$120- 150 bn in the semiconductor value chain by 2035.

Date	1st June
Publication	MSN
Link	https://www.msn.com/en-in/money/news/focus-on-design-packaging-over-wafer-race-niti-aayog/ar-AA24v5gV

Focus on design, packaging over wafer race: NITI Aayog

Story by Valtheeswaran B • 4w • 2 min read

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Focus on design, packaging over wafer race: NITI Aayog
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